HP Z8 G4 Workstation



- Integrated Front Handle 1.
- 2. **Dedicated 9.5mm Optical Drive Bay**
- 3. **Power Button**
- 4. **HDD Activity LED**

Front view

- 5. Front I/O Entry: 4 USB 3.1 Gen1 (Left-most Port has Charging Capability) Front I/O Premium: 2x USB 3.1 Gen1, 2x USB 3.1 Gen2 Type-
 - CTM (Left-most Type-A Port has Charging Capability) Note: Premium Front IO is shown on Photography
 - Media Card Reader
- 6.
- 7. 1 Headset



8. 24 DIMM Slots for DDR4 ECC Memory

- 9. 2 External 5.25"? Bays and Slimline Optical
- 10. 4 Internal 3.5"? Bays
- 11. 2 Intel® Xeon® Processors (Skylake SP) family

Internal view

- Slot 1: PCle Gen3 x4 Transforms to PCle Gen3 x8 when 2nd CPU is installed
 - Slot 2: PCle Gen3 x16
 - Slot 3: PCle Gen3 x16 Available ONLY when 2nd processor is installed
 - Slot 4: PCle Gen3 x16
 - Slot 5: PCle Gen3 x4
 - Slot 6: PCle Gen3 x16 Available ONLY when 2nd processor is installed
 - Slot 7: PCle Gen3 x4
- 13. 2 sSATA, 8 SATA (AHCI) Ports
- 14. 3 USB 2.0 Internal Ports, 1 USB 3.0 Gen1 Internal Port



Rear view

- 15. Choice of 1125W or 1450W, 90% Efficient Power Supplies
- 16. Rear I/O:

Rear Power Button

6 USB 3.1 Gen1

1 Serial

PS/2 keyboard and mouse

2 RJ-45 to integrated Gigabit LAN

1 Audio Line-In (can be retasked as microphone)

1 Audio Line-Out

17. Optional: 2 10GbE LAN ports

Overview

Overview

Form Factor Operating Systems

Tower

Preinstalled:

- Windows 10 Pro 64 for Workstations¹
- HP Linux-ready (minimal OS ready for customer OS installation)
- Red Hat® Enterprise Linux® Desktop Workstation (Paper license with 1 year support; no preinstalled OS)

Supported:

- Red Hat® Enterprise Linux® Desktop 7.42
- SUSE Linux® Enterprise Desktop 12 SP3²
- Ubuntu 16.04 LTS²

¹Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

²**Notes**: For detailed Linux® OS/hardware support information, see:

http://www.hp.com/support/linux_hardware_matrix

Note: In accordance with Microsoft's support policy, HP does not support the Windows® 7 operating system on products configured with Intel® 7th Generation and forward processors.

Available Processors

Name	Cores	Clock Speed (GHz)	Cache (MB)	Memory Speed (MT/s)	Hyper- Threading	Intel® Turbo Boost Technology ¹	Supports Intel® DCPMM® Technology ²	TDP (W)	
Intel® Xeon® Platinum 8280 processor	28	2.7 GHz	38.5	2933	YES	3.3, 4.0	YES	205	
Intel® Xeon® Platinum 8260M processor	24	2.4 GHz	35.75	2933	YES	3.1, 3.9	YES	165	
Intel® Xeon® Platinum 8260 processor	24	2.4 GHz	35.75	2933	YES	3.1, 3.9	YES	165	
Intel® Xeon® Platinum 8180 processor	28	2.5 GHz	38.50	2666	YES	3.2, 3.8	NO	205	
Intel® Xeon® Platinum 8160M processor	24	2.1 GHz	33.00	2666	YES	2.8, 3.7	NO	150	
Intel® Xeon® Platinum 8160 processor	24	2.1 GHz	33.00	2666	YES	2.8, 3.7	NO	150	
Intel® Xeon® Gold 6258R processor	28	2.7 GHz	38.50	2933	YES	4.0, 3.4	YES	205	
Intel® Xeon® Gold 6254 processor	18	3.1 GHz	24.75	2933	YES	3.9, 4.0	YES	200	
Intel® Xeon® Gold 6252 processor	24	2.1 GHz	35.75	2933	YES	2.8, 3.7 YES	YES	YES	150
Intel® Xeon® Gold 6248R processor	24	3.0 GHz	35.75	2933	YES	4.0, 3.6	YES	205	
Intel® Xeon® Gold 6248 processor	20	2.5 GHz	27.5	2933	YES	3.2, 3.9	YES	150	
Intel® Xeon® Gold 6246R processor	16	3.4 GHz	35.75	2933	YES	4.1, 4.0	YES	205	
Intel® Xeon® Gold 6246 processor	12	3.3 GHz	24.75	2933	YES	3.7, 4.2	YES	165	
Intel® Xeon® Gold 6244 processor	8	3.6 GHz	24.75	2933	YES	4.3, 4.4	YES	150	
Intel® Xeon® Gold 6242R processor	20	3.1 GHz	35.75	2933	YES	4.1, 3.8	YES	205	
Intel® Xeon® Gold 6242 processor	16	2.6 GHz	22	2933	YES	3.5, 3.9	YES	150	

Overview

24	2.4 GHz	35.75	2933	YES	4.0, 3.2	YES	165
18	2.6 GHz	24.75	2933	YES	3.3, 3.9	YES	150
18	2.6 GHz	24.75	2933	YES	3.3, 3.9	YES	150
28	2.2 GHz	38.5	2933	YES	4.0, 3.0	YES	165
26	2.1 GHz	35.75	2933	YES	4.0, 3.0	YES	150
20	2.1 GHz	27.5	2933	YES	2.8, 3.9	YES	125
16	2.9 GHz	22	2933	YES	3.9, 3.6	YES	150
12	2.7 GHz	19.25	2933	YES	3.5, 3.7	YES	125
22	2.1 GHz	30.25	2666	YES	2.8, 3.7	NO	140
18	3.0 GHz	24.75	2666	YES	3.7, 3.7	NO	200
20	2.4 GHz	27.50	2666	YES	3.1, 3.7	NO	150
12	3.2 GHz	24.75	2666	YES	3.9, 4.2	NO	165
12	3.2 GHz	24.75	2666	YES	3.9, 4.2	NO	165
8	3.5 GHz	24.75	2666	YES	4.1, 4.2	NO	150
8	3.5 GHz	24.75	2666	YES	4.1, 4.2	NO	150
16	2.6 GHz	22.00	2666	YES	3.3, 3.7	NO	150
16	2.6 GHz	22.00	2666	YES	3.3, 3.7	NO	150
18	2.3 GHz	24.75	2666	YES	3.0, 3.7	NO	140
18	2.3 GHz	24.75	2666	YES	3.0, 3.7	NO	140
20	2.0 GHz	27.5	2666	YES	2.7, 3.7	NO	125
12	3.0 GHz	24.75	2666	YES	3.6, 3.7	NO	150
8	3.2 GHz	24.75	2666	YES	3.7, 3.7	NO	130
8	3.2 GHz	24.75	2666	YES	3.7, 3.7	NO	130
14	2.6 GHz	19.25	2666	YES	3.3, 3.7	NO	140
16	2.1 GHz	22.00	2666	YES	2.8, 3.7	NO	125
6	3.4GHz	19.25	2666	YES	3.7, 3.7	NO	115
4	3.8 GHz	16.5	2666	YES	3.9, 3.9	YES	105
24	2.2 GHz	35.75	2666	YES	4.0, 2.9	YES	150
18	2.2 GHz	24.75	2666	YES	2.7, 3.9	YES	105
	18 18 28 26 20 16 12 22 18 20 12 12 12 8 8 16 16 18 18 20 12 8 8 16 16 16 4 24	18 2.6 GHz 18 2.6 GHz 28 2.2 GHz 26 2.1 GHz 16 2.9 GHz 12 2.7 GHz 22 2.1 GHz 18 3.0 GHz 20 2.4 GHz 12 3.2 GHz 12 3.5 GHz 8 3.5 GHz 16 2.6 GHz 18 2.3 GHz 12 3.0 GHz 12 3.0 GHz 12 3.0 GHz 12 3.0 GHz 12 3.2 GHz 14 2.6 GHz 14 2.6 GHz 16 2.1 GHz 4 3.8 GHz 24 2.2 GHz	18 2.6 GHz 24.75 18 2.6 GHz 24.75 28 2.2 GHz 38.5 26 2.1 GHz 35.75 20 2.1 GHz 27.5 16 2.9 GHz 22 12 2.7 GHz 19.25 22 2.1 GHz 30.25 18 3.0 GHz 24.75 20 2.4 GHz 27.50 12 3.2 GHz 24.75 12 3.2 GHz 24.75 8 3.5 GHz 24.75 8 3.5 GHz 24.75 16 2.6 GHz 22.00 16 2.6 GHz 22.00 18 2.3 GHz 24.75 18 2.3 GHz 24.75 18 2.3 GHz 24.75 12 3.0 GHz 24.75 12 3.0 GHz 24.75 8 3.2 GHz 24.75 12 3.0 GHz 24.75 14 2.6 GHz 19.25 16 2.1 GHz 22.00 <t< td=""><td>18 2.6 GHz 24.75 2933 18 2.6 GHz 24.75 2933 28 2.2 GHz 38.5 2933 26 2.1 GHz 35.75 2933 20 2.1 GHz 27.5 2933 16 2.9 GHz 22 2933 12 2.7 GHz 19.25 2933 22 2.1 GHz 30.25 2666 18 3.0 GHz 24.75 2666 20 2.4 GHz 27.50 2666 12 3.2 GHz 24.75 2666 12 3.2 GHz 24.75 2666 12 3.2 GHz 24.75 2666 8 3.5 GHz 24.75 2666 8 3.5 GHz 24.75 2666 16 2.6 GHz 22.00 2666 18 2.3 GHz 24.75 2666 18 2.3 GHz 24.75 2666 18 2.3 GHz 24.75 2666 12 3.0 GHz 27.5 2666 12<</td><td>18 2.6 GHz 24.75 2933 YES 18 2.6 GHz 24.75 2933 YES 28 2.2 GHz 38.5 2933 YES 26 2.1 GHz 35.75 2933 YES 20 2.1 GHz 27.5 2933 YES 16 2.9 GHz 22 2933 YES 12 2.7 GHz 19.25 2933 YES 12 2.7 GHz 19.25 2933 YES 12 2.7 GHz 19.25 2933 YES 12 3.0 GHz 24.75 2666 YES 18 3.0 GHz 24.75 2666 YES 12 3.2 GHz 24.75 2666 YES 12 3.2 GHz 24.75 2666 YES 8 3.5 GHz 24.75 2666 YES 16 2.6 GHz 22.00 2666 YES 18 2.3 GHz 24.75 2666</td><td>18 2.6 GHz 24.75 2933 YES 3.3, 3.9 18 2.6 GHz 24.75 2933 YES 3.3, 3.9 28 2.2 GHz 38.5 2933 YES 4.0, 3.0 26 2.1 GHz 35.75 2933 YES 4.0, 3.0 20 2.1 GHz 27.5 2933 YES 2.8, 3.9 16 2.9 GHz 22 2933 YES 3.9, 3.6 12 2.7 GHz 19.25 2933 YES 3.5, 3.7 22 2.1 GHz 30.25 2666 YES 2.8, 3.7 18 3.0 GHz 24.75 2666 YES 3.7, 3.7 20 2.4 GHz 27.50 2666 YES 3.9, 4.2 12 3.2 GHz 24.75 2666 YES 3.9, 4.2 12 3.2 GHz 24.75 2666 YES 3.9, 4.2 8 3.5 GHz 24.75 2666 YES 3.3, 3.7 1</td><td>18 2.6 GHz 24.75 2933 YES 3.3, 3.9 YES 18 2.6 GHz 24.75 2933 YES 3.3, 3.9 YES 28 2.2 GHz 38.5 2933 YES 4.0, 3.0 YES 26 2.1 GHz 27.5 2933 YES 4.0, 3.0 YES 20 2.1 GHz 27.5 2933 YES 2.8, 3.9 YES 16 2.9 GHz 22 2933 YES 3.9, 3.6 YES 12 2.7 GHz 19.25 2933 YES 3.5, 3.7 YES 22 2.1 GHz 30.25 2666 YES 3.5, 3.7 NO 18 3.0 GHz 24.75 2666 YES 3.7, 3.7 NO 12 3.2 GHz 24.75 2666 YES 3.1, 3.7 NO 12 3.2 GHz 24.75 2666 YES 3.9, 4.2 NO 12 3.2 GHz 24.75 2666</td></t<>	18 2.6 GHz 24.75 2933 18 2.6 GHz 24.75 2933 28 2.2 GHz 38.5 2933 26 2.1 GHz 35.75 2933 20 2.1 GHz 27.5 2933 16 2.9 GHz 22 2933 12 2.7 GHz 19.25 2933 22 2.1 GHz 30.25 2666 18 3.0 GHz 24.75 2666 20 2.4 GHz 27.50 2666 12 3.2 GHz 24.75 2666 12 3.2 GHz 24.75 2666 12 3.2 GHz 24.75 2666 8 3.5 GHz 24.75 2666 8 3.5 GHz 24.75 2666 16 2.6 GHz 22.00 2666 18 2.3 GHz 24.75 2666 18 2.3 GHz 24.75 2666 18 2.3 GHz 24.75 2666 12 3.0 GHz 27.5 2666 12<	18 2.6 GHz 24.75 2933 YES 18 2.6 GHz 24.75 2933 YES 28 2.2 GHz 38.5 2933 YES 26 2.1 GHz 35.75 2933 YES 20 2.1 GHz 27.5 2933 YES 16 2.9 GHz 22 2933 YES 12 2.7 GHz 19.25 2933 YES 12 2.7 GHz 19.25 2933 YES 12 2.7 GHz 19.25 2933 YES 12 3.0 GHz 24.75 2666 YES 18 3.0 GHz 24.75 2666 YES 12 3.2 GHz 24.75 2666 YES 12 3.2 GHz 24.75 2666 YES 8 3.5 GHz 24.75 2666 YES 16 2.6 GHz 22.00 2666 YES 18 2.3 GHz 24.75 2666	18 2.6 GHz 24.75 2933 YES 3.3, 3.9 18 2.6 GHz 24.75 2933 YES 3.3, 3.9 28 2.2 GHz 38.5 2933 YES 4.0, 3.0 26 2.1 GHz 35.75 2933 YES 4.0, 3.0 20 2.1 GHz 27.5 2933 YES 2.8, 3.9 16 2.9 GHz 22 2933 YES 3.9, 3.6 12 2.7 GHz 19.25 2933 YES 3.5, 3.7 22 2.1 GHz 30.25 2666 YES 2.8, 3.7 18 3.0 GHz 24.75 2666 YES 3.7, 3.7 20 2.4 GHz 27.50 2666 YES 3.9, 4.2 12 3.2 GHz 24.75 2666 YES 3.9, 4.2 12 3.2 GHz 24.75 2666 YES 3.9, 4.2 8 3.5 GHz 24.75 2666 YES 3.3, 3.7 1	18 2.6 GHz 24.75 2933 YES 3.3, 3.9 YES 18 2.6 GHz 24.75 2933 YES 3.3, 3.9 YES 28 2.2 GHz 38.5 2933 YES 4.0, 3.0 YES 26 2.1 GHz 27.5 2933 YES 4.0, 3.0 YES 20 2.1 GHz 27.5 2933 YES 2.8, 3.9 YES 16 2.9 GHz 22 2933 YES 3.9, 3.6 YES 12 2.7 GHz 19.25 2933 YES 3.5, 3.7 YES 22 2.1 GHz 30.25 2666 YES 3.5, 3.7 NO 18 3.0 GHz 24.75 2666 YES 3.7, 3.7 NO 12 3.2 GHz 24.75 2666 YES 3.1, 3.7 NO 12 3.2 GHz 24.75 2666 YES 3.9, 4.2 NO 12 3.2 GHz 24.75 2666

Overview

Overview								
Intel® Xeon® Gold 5218R processor	20	2.1 GHz	27.5	2666	YES	4.0, 2.9	YES	125
Intel® Xeon® Gold 5218 processor	16	2.3 GHz	22	2666	YES	2.8, 3.9	YES	125
Intel® Xeon® Gold 5215M processor	10	2.5 GHz	13.75	2666	YES	3.0, 3.4	YES	85
Intel® Xeon® Gold 5215 processor	10	2.5 GHz	13.75	2666	YES	3.0, 3.4	YES	85
Intel® Xeon® Gold 5120 processor	14	2.2 GHz	19.25	2400	YES	2.6, 3.2	NO	105
Intel® Xeon® Gold 5118 processor	12	2.3 GHz	16.50	2400	YES	2.7, 3.2	NO	105
Intel® Xeon® Gold 5115 processor	10	2.4 GHz	13.75	2400	YES	2.8, 3.2	NO	85
Intel® Xeon® Gold 5122 processor	4	3.6 GHz	16.50	2666	YES	3.7, 3.7	NO	105
Intel® Xeon® Silver 4216 processor	16	2.1 GHz	22	2400	YES	2.7, 3.2	NO	100
Intel® Xeon® Silver 4215R processor	8	3.2 GHz	11	2400	YES	4.0, 3.6	YES	130
Intel® Xeon® Silver 4215 processor	8	2.5 GHz	11	2400	YES	3.0, 3.5	YES	85
Intel® Xeon® Silver 4214R processor	12	2.4 GHz	16.5	2400	YES	3.0, 3.5	NO	100
Intel® Xeon® Silver 4214Y processor	12	2.2 GHz	16.5	2400	YES	2.7, 3.2	NO	105
Intel® Xeon® Silver 4214 processor	12	2.2 GHz	16.5	2400	YES	2.7, 3.2	NO	85
Intel® Xeon® Silver 4210R processor	10	2.4 GHz	13.75	2400	YES	2.9, 3.2	NO	100
Intel® Xeon® Silver 4210 processor	10	2.2 GHz	13.75	2400	YES	2.7, 3.2	NO	85
Intel® Xeon® Silver 4208 processor	8	2.1 GHz	11	2400	YES	2.5, 3.2	NO	85
Intel® Xeon® Silver 4116 processor	12	2.1 GHz	16.50	2400	YES	2.4, 3.0	NO	85
Intel® Xeon® Silver 4114 processor	10	2.2 GHz	13.75	2400	YES	2.5, 3.0	NO	85
Intel® Xeon® Silver 4112 processor	4	2.6 GHz	8.25	2400	YES	2.9, 3.0	NO	85
Intel® Xeon® Silver 4110 processor	8	2.1 GHz	11.00	2400	YES	2.4, 3.0	NO	85
Intel® Xeon® Silver 4108 processor	8	1.8 GHz	11.00	2400	YES	2.1, 3.0	NO	85
Intel® Xeon® Silver 3206R processor	8	1.9 GHz	11.00	2133	YES	N/A	NO	85
Intel® Xeon® Bronze 3204 processor	6	1.9 GHz	8.25	2133	YES	N/A	NO	85
Intel® Xeon® Bronze 3106 processor	8	1.7 GHz	11.00	2133	NO	N/A	NO	85
Intel® Xeon® Bronze 3104 processor	6	1.7 GHz	8.25	2133	NO	N/A	NO	85

All Z8G4 Intel® Xeon® CPUs Feature Intel® vProTM Technology.

¹The specifications shown in this column represent the following: (all core maximum turbo steps, one core maximum turbo steps). Turbo boost stepping occurs in 100MHz increments. Processors

Overview

that do not have turbo functionality are denoted as N/A.

Available Processors

Disclaimers

When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Color

Convertibility No

Expansion Slots (see

more details)

Slot 1:

Black

system board section for PCIe Gen3 x4 - Transforms to PCIe Gen3 x8 when 2nd CPU is installed

Slot 2:

PCIe Gen3 x16

SInt 3:

PCIe Gen3 x16 - Available ONLY when 2nd processor is installed

Slot 4:

PCIe Gen3 x16

Slot 5:

PCIe Gen3 x4

PCIe Gen3 x16 - Available ONLY when 2nd processor is installed

Slot 7:

PCIe Gen3 x4

Note: The PCIe x4 and PCIe x8 connectors above are open ended, allowing a PCIe x16 card to be seated in the slot.

Expansion Bays (see details)

4 internal 3.5" bays (All 4 include acoustic dampening rail assemblies)

storage section for more 2 external 5.25" bays (175mm depth limit)

1 dedicated 9.5mm slim optical disk drive bay

Front I/O

 Base: 4 USB 3.1 Gen1 Type-A connector. Left most connector has charging capability, 1 Combo Headset, 1 Optional Media Card Reader

 Premium: 2 USB 3.1 Gen1 Type-A connector. Left most connector has charging capability, 2 USB 3.1 Gen2 Type-CTM connector, 1 Combo Headset, 1 Optional Media Card Reader

Internal I/O

Internal Slot 1 CPU1: PCIe Gen3 x8 - always available

Internal Slot 2 CPU2: PCIe Gen3 x8 - available when 2nd CPU is installed

2 USB 2.0 ports available with a single 2x5 header

1 USB 2.0 port available with a 1x6 header

1 USB 3.1 Gen1 and 1 USB 2.0 port available with a 2x6 header

Overview

Notes: The 2x5 header can be converted to a standard (Type-A) USB 2.0 connector through the use of one

HP Internal USB Port Kit (EM165AA). This port kit uses one half of the 2x5 header.

The 1x6 header can be converted to a standard (Type-A) USB 2.0 connector through the use of one HP

Internal USB Port Kit (EM165AA). This port kit uses 5 pin positions on the header.

The 2x6 header can be converted to a standard (Type-A) USB 2.0 connector through the use of one HP

Internal USB Port Kit (EM165AA). This port kit

uses one half of the 2x6 header.

Rear I/O 6 USB 3.1 Gen1 (aka USB 3.0), 1 Serial, PS/2 keyboard and mouse, 2 RJ-45 to integrated Gigabit LAN, 1

Audio Line-In (can be retasked as microphone), 1 Audio Line-Out

Optional: 2 RJ-45 to 10GbE LAN ports

Interfaces Supported 10 channel SATA 6.0 Gb/s interface

Factory integrated RAID available for SATA drives (RAID 0, 1 and 10)

Internal USB 3.1 Gen1, USB 3.1 Gen2, USB 2.0

On-board RAID Support SATA RAID 0 Striped Array

SATA RAID 1 Mirrored Array SATA RAID 10 Striped/Mirrored SATA RAID 5 Parity Array

Chassis Dimensions (H x

W x D)

Footprint: H: 17.5" [444.5mm]

W: 8.5" [215.9mm]

D: 21.7" [551.2mm] (measured to the rear of service panel)

Maximum: H: 17.5" [444.5mm]

W: 8.5" [215.9mm]

D: 21.85" [555.2mm] (measured to the embossment for the rear chassis fans)

Packaged Dimensions H: 25" (636mm)

W: 13.1" (332mm) D: 28.9" (734mm)

Rack Dimensions 5U

Weight Exact weights depend upon configuration (System weight only).

Minimum: 22.4kg (49.4lbs.) Typical: 23.7kg (52.2lbs.) Maximum: 31.7kg (70lbs.)

Temperature Operating: 5° to 35°C (40° to 95°F)

Non-operating: -40° to 60°C (-40° to 140°F)

Humidity Operating: Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90%, non-condensing, 35° C maximum wet bulb

Maximum Altitude (non-

pressurized)

Operating: 3,048m (10,000ft) Non-operating: 9,144m (30,000ft)

Note: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1° C (1.8° F) per

305 m (1,000 feet) elevation increase

Power Supply Choice of:

1125W/100V/15A 90% Efficient wide-ranging, active Power Factor Correction The power delivery system includes four 6+2-pin graphics power cables.

1450W/200V/10A 90% Efficient wide-ranging, active Power Factor Correction The power delivery system

includes four 6+2-pin graphics power cables.

Available in limited regions

1450W/100V/20A 90% Efficient wide-ranging, active Power Factor Correction The power delivery system includes four 6+2-pin graphics power cables.



1700W/200V/10A 90% Efficient wide-ranging, active Power Factor Correction The power delivery system includes four 6+2-pin graphics power cables.

Notes: The 1125W/100V/15A (1450W at 200V Input Voltage) power supply can also supply 1275W of output power when the input voltage is greater than 105V. If the input voltage is less than 105V, but greater than 90V for any reason, the maximum power that can be drawn is 1125W. An uninterruptible power supply (UPS) is highly recommended if 1275W output power is desired.

The 1125W Power Supply can also supply 1450W of output power when the input voltage is greater than 200V under all conditions.

The 1450W/100V/20A (1700W at 200V Input Voltage) power supply can also supply 1550W of output power when the input voltage is greater than 105V. If the input voltage is less than 105V, but greater than 90V for any reason, the maximum power that can be drawn is 1450W. An uninterruptible power supply (UPS) is highly recommended if 1550W output power is desired.

The 1450W Power Supply can also supply 1700W of output power when the input voltage is greater than 200V under all conditions.

The 1450W/100V/20A chassis is shipped with a 20A power cord and requires a 20A outlet in an environment with 100V/110V. Site modification may be required. Check with your sales lead and click here for the Site Prep Guide.

The Z8 G4 power supply efficiency reports can be found at these links:

1125W - Link:

https://plugloadsolutions.com/psu_reports/HP%20Inc_DPS-1125BB%20A 1125W ECOS%204825 Report.pdf

1450W - Link:

https://plugloadsolutions.com/psu_reports/HP%20Inc_DPS-1450AB%20A_1450W_ECOS%204826_Report.pdf

Workstation ISV Certifications See the latest list of certifications at

http://www.hp.com/united-states/campaigns/workstations/partnerships.html



Processors	Intel® Xeon® processor Scalable family	Factory Configured	Option Kit	Option Kit Part Number	Suppor Notes
	Intel® Xeon® Platinum 8280 processor	Υ	Υ	5YZ53AA	1
	Intel® Xeon® Platinum 8260M processor	Υ	Υ	5YZ52AA	1
	Intel® Xeon® Platinum 8260 processor	Υ	Υ	5YZ51AA	1
	Intel® Xeon® Platinum 8180 processor	Υ	Υ	1XM54AA	
	Intel® Xeon® Platinum 8160M processor	Υ	Υ	1XM55AA	
	Intel® Xeon® Platinum 8160 processor	Υ	Υ	1XM56AA	
	Intel® Xeon® Gold 6258R processor	Υ	Υ	9VA96AA	1
	Intel® Xeon® Gold 6254 processor	Υ	Υ	5YZ50AA	1
	Intel® Xeon® Gold 6252 processor	Υ	Υ	5YZ49AA	1
	Intel® Xeon® Gold 6248R processor	Υ	Υ	9VA93AA	1
	Intel® Xeon® Gold 6248 processor	Υ	Υ	5YZ48AA	1
	Intel® Xeon® Gold 6246R processor	Υ	Υ	9VA92AA	1
	Intel® Xeon® Gold 6246 processor	Υ	Υ	7UD05AA	1
	Intel® Xeon® Gold 6244 processor	Υ	Υ	5YZ47AA	1
	Intel® Xeon® Gold 6242R processor	Υ	Υ	9VA91AA	1
	Intel® Xeon® Gold 6242 processor	Υ	Υ	5YZ46AA	1
	Intel® Xeon® Gold 6240R processor	Υ	Υ	9VA90AA	1
	Intel® Xeon® Gold 6240Y processor	Υ	Υ	5YZ45AA	1
	Intel® Xeon® Gold 6240 processor	Υ	Υ	5YZ44AA	1
	Intel® Xeon® Gold 6238R processor	Υ	Υ	9VA89AA	1
	Intel® Xeon® Gold 6230R processor	Υ	Υ	9VA88AA	1
	Intel® Xeon® Gold 6230 processor	Υ	Υ	5YZ41AA	1
	Intel® Xeon® Gold 6226R processor	Υ	Υ	9VA86AA	1
	Intel® Xeon® Gold 6226 processor	Υ	Υ	5YZ40AA	1
	Intel® Xeon® Gold 6152 processor	Υ	Υ	1XM57AA	
	Intel® Xeon® Gold 6154 processor	Υ	Υ	1XM58AA	
	Intel® Xeon® Gold 6148 processor	Υ	Υ	1XM59AA	
	Intel® Xeon® Gold 6146 processor	Υ	Υ	2RX97AA	
	Intel® Xeon® Gold 6144 processor	Υ	Υ	2RX96AA	
	Intel® Xeon® Gold 6142M processor	Υ	Υ	1XM60AA	
	Intel® Xeon® Gold 6142 processor	Υ	Υ	1XM61AA	
	Intel® Xeon® Gold 6140M processor	Υ	Υ	1XM63AA	
	Intel® Xeon® Gold 6140 processor	Υ	Υ	1XM64AA	
	Intel® Xeon® Gold 6138 processor	Υ	Υ	3GG97AA	
	Intel® Xeon® Gold 6136 processor	Υ	Υ	1XM62AA	
	Intel® Xeon® Gold 6134M processor	Υ	Υ	1XM65AA	
	Intel® Xeon® Gold 6134 processor	Υ	Υ	1XM66AA	
	Intel® Xeon® Gold 6132 processor	Υ	Υ	1XM67AA	
	Intel® Xeon® Gold 6130 processor	Υ	Υ	1XM68AA	
	Intel® Xeon® Gold 6128 processor	Υ	Υ	1XM69AA	
	Intel® Xeon® Gold 5222 processor	Υ	Υ	5YZ39AA	1
	Intel® Xeon® Gold 5220R processor	Υ	Υ	8BD06AA/AT	1
	Intel® Xeon® Gold 5220 processor	Υ	Υ	5YZ38AA	1

1



Supported Components

Intel® Xeon® Gold 5218R processor	Υ	Υ	9VA84AA	
Intel® Xeon® Gold 5218 processor	Υ	Υ	5YZ37AA	
Intel® Xeon® Gold 5215M processor	Υ	Υ	5YZ36AA	
Intel® Xeon® Gold 5215 processor	Υ	Υ	5YZ35AA	
Intel® Xeon® Gold 5120 processor	Υ	Υ	1XM70AA	
Intel® Xeon® Gold 5118 processor	Υ	Υ	1XM71AA	
Intel® Xeon® Gold 5122 processor	Υ	Υ	1XM72AA	
Intel® Xeon® Gold 4216 processor	Υ	Υ	5YZ34AA	
Intel® Xeon® Gold 4215R processor	Υ	Υ	9VA82AA	
Intel® Xeon® Gold 4215 processor	Υ	Υ	5YZ33AA	
Intel® Xeon® Gold 4214R processor	Υ	Υ	8BD03AA/AT	
Intel® Xeon® Gold 4214Y processor	Υ	Υ	5ZB34AA	
Intel® Xeon® Gold 4214 processor	Υ	Υ	5YZ32AA	
Intel® Xeon® Gold 4210R processor	Υ	Υ	8BD02AA	
Intel® Xeon® Gold 4210 processor	Υ	Υ	5YZ31AA	
Intel® Xeon® Gold 4208 processor	Υ	Υ	5YZ30AA	
Intel® Xeon® Silver 4116 processor	Υ	Υ	1XM73AA	
Intel® Xeon® Silver 4114 processor	Υ	Υ	1XM74AA	
Intel® Xeon® Silver 4112 processor	Υ	Υ	1XM75AA	
Intel® Xeon® Silver 4110 processor	Υ	Υ	3GG96AA	
Intel® Xeon® Silver 4108 processor	Υ	Υ	1XM76AA	
Intel® Xeon® Bronze 3206R processor	Υ	Υ	8BD00AA	
Intel® Xeon® Gold 3204 processor	Υ	Υ	5YZ29AA	
Intel® Xeon® Bronze 3106 processor	Υ	Υ	1XM77AA	
Intel® Xeon® Bronze 3104 processor	Υ	Υ	1XM78AA	
1 Ontions kits available for espend processor ungrade				

¹ Options kits available for second processor upgrade.

Disclaimers: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate featur within each processor family, not across different processor families.

Note 1: Intel® DCPMM® (Data Center Persistent Memory) Supported.

Monitors / Displays		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Z Display Z22n G2		Υ	1JS05AA	
	HP Z Display Z23n G2		Υ	1JS06AA	
	HP Z Display Z24i G2		Υ	1JS08AA	
	HP Z Display Z24n G2		Υ	1JS09AA	
	HP Z Display Z24nf G2		Υ	1JS07AA	
	HP Z Display Z27n G2		Υ	1JS10AA	
	HP Z Display Z27s (4K display)		Υ	J3G07AA	
	Supported by all operating systems available from HP Screen size measured diagonally				

Storage / Hard Drives

SAS Hard Drives	SAS Hard Drives for HP Workstations	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
	HP 300GB 15k SAS SFF	Υ	Υ	L5B74AA		
	NOTE: SAS controller add-in card required					

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA (Serial ATA) Hard Drives for HP Workstations				
	500GB SATA 7200RPM 6Gb/s 3.5"? HDD	Υ	Υ	LQ036AA	
	500GB SATA 7200RPM 6Gb/s OPAL2 SFF 3.5"? HDD	Υ	Υ	D8N29AA	
	1TB SATA 7200RPM 3.5"? HDD	Υ	Υ	LQ037AA	
	1TB SATA 7200RPM Ent 3.5"? HDD	Υ	Υ	WOR10AA	
	2TB SATA 7200RPM HDD CMR	Υ	Υ	QB576AA	
	2TB SATA 7200RPM HDD SMR				
	4TB SATA 7200RPM Ent 3.5"? HDD	Υ	Υ	K4T76AA	
	6TB SATA 7200RPM Ent 3.5"? HDD	Υ	Υ	3DH90AA	
	NOTES:				

Up to (5) 3.5-inch 7200 rpm SATA drives: 500 GB, 1.0, 2.0, 4.0 TB; 20TB max total



SATA Solid State Drives	HP Solid State Drives (SSDs) for Workstations	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 256GB SATA SSD	Υ	Υ	A3D26AA	
	HP 512GB SATA SSD	Υ	Υ	D8F30AA	
	HP 1TB SATA SSD	Υ	Υ	F3C96AA	
	HP 2TB SATA SSD	Υ	Υ	Y6P08AA	
	HP 256GB SATA SED OPAL2 SSD	Υ	Υ	G7U67AA	
	HP 512GB SATA SED OPAL2 SSD	Υ	Υ	N8T26AA	
	HP 240GB SATA Enterprise SSD	Υ	Υ	T3U07AA	
	HP 480GB SATA Enterprise SSD	Υ	Υ	T3U08AA	

PCIe Solid State Drives		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	PCIe SSDs for HP Workstations				
	HP Z Turbo Drive 256GB MLC Z8G4 SSD Module	N	N	EOL	5
	HP Z Turbo Drive 512GB MLC Z8G4 SSD Module	N	N	EOL	5
	HP Z Turbo Drive 1TB MLC Z8G4 SSD Module	N	N	EOL	5
	HP Z Turbo Drive 256GB TLC Z8G4 SSD Module	Υ	Υ	1PD53AA	2
	HP Z Turbo Drive 512GB TLC Z8G4 SSD Module	Υ	Υ	1PD54AA	2
	HP Z Turbo Drive 1TB TLC Z8G4 SSD Module	Υ	Υ	1PD55AA	2
	HP Z Turbo Drive 2TB TLC Z8G4 SSD Module	Υ	Υ	3KP41AA	2
	HP Z Turbo Drive 256GB SED Z8G4 SSD Module	N	N	EOL	5
	HP Z Turbo Drive 512GB SED Z8G4 SSD Module	N	N	EOL	5
	HP Z Turbo Drive 256GB MLC Z8 G4 SSD Kit	N	N	EOL	5
	HP Z Turbo Drive 512GB MLC Z8 G4 SSD Kit	N	N	EOL	5
	HP Z Turbo Drive 1TB MLC Z8 G4 SSD Kit	N	N	EOL	5
	HP Z Turbo Drive 256GB TLC Z8 G4 SSD Kit	Υ	Υ	1PD47AA	4
	HP Z Turbo Drive 512GB TLC Z8 G4 SSD Kit	Υ	Υ	1PD48AA	4
	HP Z Turbo Drive 1TB TLC Z8 G4 SSD Kit	Υ	Υ	1PD49AA	4
	HP Z Turbo Drive 2TB TLC Z8 G4 SSD Kit	Υ	Υ	3KP40AA	4
	HP Z Turbo Drive 256GB SED Z8 G4 SSD Kit	Υ	Υ	2SA33AA	4
	HP Z Turbo Drive 512GB SED Z8 G4 SSD Kit	Υ	Υ	2SA35AA	4
	HP Z Turbo Drive 1TB SED Z8 G4 SSD Kit	Υ	Υ	6YT75AA	4
	HP Z Turbo Drive 1TB SED Z8 G4 SSD Module	Υ	Υ	6YT79AA	2
	HP 1x256GB M.2 2280 PCIe NVMe TLC SSD Z8 G4 Kit	Υ	Υ	8PE71AA	3
	HP 1x512GB M.2 2280 PCIe NVMe TLC SSD Z8 G4 Kit	Υ	Υ	8PE72AA	3
	HP 1x1TB M.2 2280 PCIe NVMe TLC SSD Z8 G4 Kit	Υ	Υ	8PE73AA	3
	HP 256GB M.2 2280 PCIe NVMe TLC SSD Module	N	Υ	8PE62AA	2
	HP 512GB M.2 2280 PCIe NVMe TLC SSD Module	N	Υ	8PE63AA	2
	HP 1TB M.2 2280 PCIe NVMe TLC SSD Module	N	N	8PE64AA	2
	HP Z Turbo Drive Quad Pro				

Supported Components

HP Z Turbo Drive Quad Pro 2x256GB PCIe TLC SSD	Υ	Υ	4YZ38AA	1
HP Z Turbo Drive Quad Pro 2x512GB PCIe TLC SSD	Υ	Υ	4YZ39AA	1
HP Z Turbo Drive Quad Pro 2x1TB PCIe TLC SSD	Υ	Υ	4YZ40AA	1
HP Z Turbo Drive Quad Pro 2x2TB PCIe TLC PCIe SSD	Υ	Υ	3KP42AA	
HP Z Turbo Drive Quad Pro 256GB TLC SSD module	N	Υ	4YZ35AA	2
HP Z Turbo Drive Quad Pro 512GB TLC SSD module	N	Υ	4YZ36AA	2
HP Z Turbo Drive Quad Pro 1TB TLC SSD module	N	Υ	4YZ37AA	2
HP Z Turbo Drive Dual Pro				
HP Z Turbo Drive Dual Pro 256GB TLC SSD	Υ	Υ	4YF60AA	3
HP Z Turbo Drive Dual Pro 512GB TLC SSD	Υ	Υ	4YF61AA	3
HP Z Turbo Drive Dual Pro 1TB TLC SSD	Υ	Υ	4YF62AA	3
HP Z Turbo Drive Dual Pro 2TB TLC SSD	Υ	Υ	4YF63AA	3
HP 256GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	Υ	Υ	8PE74AA	3
HP 512GB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	Υ	Υ	8PE75AA	3
HP 1TB M.2 2280 PCIe NVMe TLC SSD Dual Pro Kit	Υ	Υ	8PE76AA	3
Intel® 905p Series SSD (Opatane SSD)				
Intel® Optane SSD 905p 280GB AiC**	Υ	Υ	2SC47AA	
Intel® Optane SSD 905p 480GB AiC**	Υ	Υ	2SC48AA	
Intel® Optane SSD 905p 380GB M.2 SSD Module	Υ	Υ	6LA66AA	

NOTE 1: Dual M.2 SSD drive plus Quad Pro carrier

NOTE 2: M.2 SSD drive only designed to be installed in Quad Pro, Dual Pro or personality module

NOTE 3: Kit includes single M.2 SSD, dual pro carrier and heat sink

NOTE 4: Kit includes single M.2 SSD, dual personality module carrier and heat sink **NOTE 5:** These M.2 SSD Kits and modules are End of Life and no longer available.

^{**} PCIe card installed in standard PCIe x4 slot

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SAS Controller				
	MicroSemi SmartHBA2100-4i4e SAS Controller	Υ	Υ	1FV90AA	

^{*}For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB o system disk is reserved for system recovery software



Graphics

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported # of cards
Graphics Cable Adapters					
HP miniDP-to-DP Adapter	Υ	Υ			
HP miniDP-to-DP Adapter (2-pack)	Υ	N			
HP miniDP-to-DP Adapter (4-pack)	Υ	N			
HP miniDP-to-DP Adapter (8-pack)	Υ	N			
HP DisplayPort to Dual Link DVI Adapter	Υ	Υ	NR078AA		
HP DisplayPort to DVI-D Adapter	Υ	Υ	FH973AA		
HP DisplayPort to DVI-D Adapter (2-pack)	Υ	N			
HP DisplayPort to DVI-D Adapter (4-pack)	Υ	N			
HP DisplayPort to DVI-D Adapter (6-pack)	Υ	N			
HP DisplayPort to VGA Adapter	Υ	Υ	AS615AA		
HP DisplayPort to HDMI Adapter	Υ	Υ	K2K92AA		
NVIDIA SLI 2-slot Graphics Connector	Υ	Υ	2YY84AA		
Entry 3D					
NVIDIA® Quadro® P400 2GB Graphics	Υ	Υ	1ME43AA		2
NVIDIA® Quadro® P600 2GB Graphics	Υ	Υ	1ME42AA		2
NVIDIA® Quadro® P620 2GB Graphics	Υ	Υ	3ME25AA		2
AMD FirePro [™] W2100 2GB Graphics	Υ	Υ	J3G91AA		2
Mid-range 3D					
NVIDIA® Quadro® P1000 4GB Graphics	Υ	Υ	1ME01AA		4
NVIDIA® Quadro® P2000 5GB Graphics	Υ	Υ	1ME41AA		4
NVIDIA® Quadro® P2200 5GB Graphics	Υ	Υ	6YT67AA		4
AMD Radeon™ Pro WX 3100 4GB Graphics	Υ	Υ	2TF08AA		4
AMD Radeon™ Pro WX 3200 4GB Graphics	Υ	Υ	6YT68AA		4
AMD Radeon™ Pro WX 4100 4GB Graphics	Υ	Υ	ZOB15AA		4
High End 3D					
NVIDIA® Quadro® P4000 8GB Graphics	Υ	Υ	1ME40AA		3
NVIDIA® Quadro RTX 4000 8GB Graphics	Υ	Υ	5JV89AA		3
AMD Radeon™ Pro WX 7100 8GB Graphics	Υ	Υ	ZOB14AA		3
Ultra High-End 3D					
NVIDIA® Quadro® GP100 16GB Graphics	Υ	Υ	1ZE81AA		3
NVIDIA® Quadro® GV100 32GB Graphics	Υ	Υ	3ME26AA		3
NVIDIA® Quadro® P5000 16GB Graphics	Υ	Υ	ZOB13AA		3
NVIDIA® Quadro® P6000 24GB Graphics	Υ	Υ	ZOB12AA		3
NVIDIA® Quadro RTX 5000 16GB Graphics	Υ	Υ	5JH81AA		2
NVIDIA® Quadro RTX 6000 24GB Graphics	Υ	Υ	5JH80AA		2
NVIDIA® Quadro RTX 8000 48GB Graphics	Υ	Υ	6NB51AA		2
AMD Radeon TM Pro WX 9100 16GB Graphics	Υ	Υ	2TF01AA		1
NVIDIA® Quadro® Sync II	Υ	Υ	1WT20AA		



Memory

	Factory Configured	Option Kit	Option Kit Part Number	Suppor Notes
DDR4-2666 ECC Registered DIMMs				
8GB (1x8GB) DDR4-2666 ECC Reg Memory	Υ	Υ	1XD84AA	1, 3
16GB (1x16GB) DDR4-2666 ECC Reg Memory	N	Υ	1XD85AA	1,3
32GB (1x32GB) DDR4-2666 ECC Reg Memory	N	Υ	1XD86AA	1,3
64GB (1x64GB) DDR4-2666 ECC LR Memory	N	Υ	1XD87AA	1,2,3
128GB (1x128GB) DDR4-2666 ECC 3DS LR Memory	N	Υ	3GE82AA	1,2,3
8GB (1x8GB) DDR4-2933 ECC Reg Memory	Υ	Υ	5YZ56AA	1,3
16GB (1x16GB) DDR4-2933 ECC Reg Memory	N	Υ	5YZ54AA	1,3
32GB (1x32GB) DDR4-2933 ECC Reg Memory	N	Υ	5YZ55AA	1,3
64GB (1x64GB) DDR4-2399 ECC Reg Memory	N	Υ	5YZ57AA	1,3

NOTES:

- 1. For details on the supported memory configurations on the HP Z8 G4 Workstation, please refer to the System Technical Specifications System Board section of this document.
- 2. Sleep (S3 state) support:
 - Sleep (S3 state) may not be supported with non-HP validated and qualified 64 GB LR DIMMs.
 - Sleep (S3 state) is not supported with 128 GB 3DS LR DIMMs
- You cannot intermix different types of memory. The system will not work if LR DIMMs, RDIMMs or 3DS LR DIM are intermixed.

DIMMs should be equally distributed across all six memory channels for optimal performance.

Each processor supports up to 6 channels of DDR4 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If a 2400MT/s capable CPU is used in the system, t maximum speed the memory will run at is 2400MT/s, regardless of the specified speed of the memory.

MT/s = Million Transfers per second

The Z8 G4 is designed to work ONLY with DDR4 memory. The system will not work with DDR3 memory.

NOTE: Factory-configured CTO (xxxxxAV) and aftermarket AMO (xxxxxAA, xxxxxAT) HP memory part numbers designated as "2666"? will be transitioned to use "2933" speed memory components. This does not affect HP par number availability nor does it affect system performance or operation. All hardware configurations currently supporting HP memory part numbers designated as "2666"? have been tested to work with "2933" memory and a fully-supported by HP under standard support terms.



NVDIMM Memory		Factory Configured	Option Kit	Option Kit Part Number	Suppor Notes
	Intel® Optane TM DC Persistent Memory (DCPMM)	_			
	128GB (1x128GB) DC Persistent Memory Module	Υ	Υ	9NH78AA	1
	256GB (2x128GB) DC Persistent Memory Configuration	Υ	N		1
	512GR (4y128GR) DC Persistent Memory Configuration	V	N		1 2

NOTE 1: Supported only with Xeon 82xx, 62xx, 52xx and 4215/4215R processors.

- a. Available as factory configured in Memory Mode or Storage Mode.
- b. Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT/s.
- c. Operating System Support:
 - i. Windows 10 Pro 64 for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
- d. Detailed setup, security and support information may be found in the Intel® OptaneTM DC Persistent Memo Configuration and Setup on HP Z6 G4 and Z8 G4 Workstation white paper.
- e. DCPMM solutions require additional DRAM memory to be included in the solution:
 - i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used as cache. The amount of included DRAM memory is based on an 8:1 DCPMM to DRAM capacity ratio.
 - Systems configured with DCPMM in Storage Mode will require DRAM System Memory to be ordered separately.
 - iii. DCPMM Memory will report approximately 2% less than advertised capacity.
- f. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor system.
 - i. Z8 G4 Note: "M"? processors support a total memory limit < =2TB per processors or 4TB per dual proc system
 - When Configured in Memory Mode, additional DRAM does not count against maximum processor mer
- g. Maximum number of DCPMM modules in a Z8G4 is 6 per processor.
- h. Customer is responsible for additional required DRAM when adding DCPMM modules in Memory Mode.
- i. HP Z8G4 configured with some AMD Graphics are limited to 1TB of total DCPMM and DRAM memory. See *I* Graphics specifications for details.

NOTE 2: Requires 2nd processor option.

Multimedia and Audio Devices

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Integrated Realtek HD ALC221 Audio	Υ	N		



Optical and Removable Storage

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SlimTray Optical Drives				
HP 9.5mm Slim Blu Ray Disc Writer	Υ	Υ	K3R65AA	1
HP 9.5mm Slim DVD ROM	Υ	Υ	K3R63AA	1
HP Half Height Optical Drives				
HP HH DVD Writer (16X RW DVD-R)	N	Υ	4AR67AA	
HP 9.5mm Slim DVD Writer*	Υ	Υ	K3R64AA	1
HP SD Card Reader				
HP SD 4 Card Reader	Υ	Υ	YOL99AA	
HDD Frame/Carriers				
HP DX175 Removable HDD Carrier	N	Υ	1ZX72AA	
HP DX175 Removable HDD Frame/Carrier	N	Υ	1ZX71AA	
NVMe Frame/Carrier				
HP QX310 Removable NVMe Frame/Carrier w/PCIe card	Υ	N		
HP QX310 Removable Carrier only	N	Υ	8GQ91AA/AT	

NOTE 1: Installing an optical drive into Z8 G4 requires a 5.25"? external bay adapter.

*Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Networking and Communications



	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Intel® I350-T2 PCIe Dual Port Gigabit NIC	Υ	Υ	V4A91AA	
Intel® 1350-T4 PCIe 4-Port Gigabit NIC	N	Υ	W8X25AA	
Intel® Ethernet I210-T1 PCIe x1 Gb NIC	Υ	Υ	E0X95AA	
Aquantia® NBASE-T 5GbE PCIe NIC	N	Υ	1PM63AA	
Intel® X550-T2 10GbE Dual Port NIC	Υ	Υ	1QL46AA	
Intel® X710-DA2 10GbE SFP+ Dual Port NIC	Υ	Υ	1QL47AA	1
HP 10GBASE-T Dual NIC Module Z6/8 G4	Υ	Υ	1QL49AA	
Intel® 8265 802.11 a/b/g/n/ac&BT PCIe	N	Υ	1QL48AA	
Intel® 9260 802.11 a/b/g/n/ac&BT PCIe	N	Υ	6SL33AA	US/CAN only
HP 10GbE SFP+ SR 1st Transceiver	Υ	Υ	C3N53AA	
Intel® Wi-Fi 6 AX200 & BT PCIe	N	Υ	7CE01AA	
Note 1: Windows 7 is NOT supported				

Racking and Physical Security

-	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Security Cable with Kensington Lock	N	Υ	PC766A	
HP Chassis Intrusion Sensor	Υ	N		1
HP Z640/Z840/Z8G4 Rail Rack Kit	N	Υ	2FZ77AA	
HP Z8 Rack Rail Upgrade Kit	N	Υ	2FZ76AA	
HP Keyed Cable Lock 10mm	N	Υ	T1A62AA	
NOTE 1: Standard on all systems				

Input Devices

			Option Kit	
	Factory Configured	Option Kit	Part Number	Support Notes
HP Wireless Business Slim Keyboard and Mouse	Υ	Υ	N3R88AA	
Business Slim PS/2 Wired Keyboard	Υ	Υ	N3R86AA	
USB Business Slim Wired Keyboard	Υ	Υ	N3R87AA	
USB Premium Wired Keyboard	Υ	Υ	Z9N40AA	
USB Wired SmartCard CCID Keyboard	Υ	Υ	E6D77AA	
3Dconnexion CADMouse	Υ	Υ	M5C35AA	
HP Optical USB Mouse	Υ	Υ	QY777AA	
HP PS/2 Mouse	Υ	Υ	QY775AA	
USB 1000dpi Laser Mouse	Υ	Υ	QY778AA	
HP USB Hardened Mouse	Υ	Υ	P1N77AA	

Other Hardware



	Factory		Option Kit Part	
	Configured	Option Kit	Number	Support Notes
HP Internal USB Port Kit	N	Υ	EM165AA	Note 1
HP eSATA PCI Cable Kit	Υ	Υ	GM110AA	Note 2
HP Optical Bay HDD Mounting Bracket	N	Υ	NQ099AA	Note 3
HP 2.5in HDD/SSD 2-in-1 ODD Bay Bracket	N	Υ	K4T74AA	Note 4
HP Z Premium Front I/O 2xUSB-A 2xUSB-C	N	Υ	1XM32AA	
HP Power Cord Kit	Υ	N		
HP Workstation Mouse Pad	Υ	N		Japan Only
HP ENERGY STAR® Certified Configuration	Υ	N		

NOTE 1: The HP Internal USB Port kit has a single USB 2.0 type A connector.

NOTE 2: No hot plug / hot swap supported with eSATA

NOTE 3: NQ099AA used to install greater than four 3.5" HDDs in the factory or when purchasing Aftermarke Option (AMO) drives

NOTE 4: K4T74AA used to install greater than four 2.5" HDD/SSDs in the factory or when purchasing

Aftermarket Option (AMO) drives

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Sobey Video Editing SW	Υ	N		China Only
	SW HP RGS for Z	Υ	N		
	HP Sure Start Gen3	Υ	N		
	HP Performance Advisor	Υ	N		

Operating Systems

Support Notes

Windows 10 Pro 64

Windows 7 Professional 64-bit

Windows 10 Downgrade to Windows 7

HP Linux® Installer Kit

Red Hat ® Enterprise Linux® (RHEL) Workstation - Paper License (1yr)

Note 1

NOTE 1: This second OS must be ordered with the HP Linux® Installer Kit as the first OS.

NOTE 2: includes drivers for 64-bit OS versions of RHEL 6 & 7, SUSE Linux® Enterprise Desktop 11 and Ubuntu 14.04.

For detailed Linux® OS/hardware support information, see:

http://www.hp.com/support/linux_hardware_matrix

For detailed Windows 7 OS hardware support information see http://h10032.www1.hp.com/ctg/Manual/c05857891.pdf.

Intel Xeon® SP Processors: Platinum 8100, Gold 6100, Gold 5100, Silver 4100, & Bronze 3100 Family support Microsoft Windows 7 Professional 64-bit.



System Technical Specifications

System Board

System Board Form Factor Custom Form Factor, 16.34"?x15.25"? (415mm x 387.2mm)

Processor Socket Dual FCLGA3647 (Socket P)

CPU Bus Speed UPI: Up to 10.4GT/second, depending on processor

Chipset Intel® C622 Chipset **Super I/O Controller** Nuvoton SIO15

Memory Expansion Slots 24 slots (12 slots per CPU)

Memory Type Supported DDR4 R-DIMM (Registered), ECC: 8GB, 16GB, 32GB, and 64GB

DDR4 LR-DIMM (Load Reduced), ECC: 64GB

DDR4 3DS LR DIMM (3D Stacked, Load Reduced), ECC: 128GB

Memory Modes NUMA (Non-Uniform Memory Architecture), Memory Node Interleave

Memory Speed Supported 2133MT/s, 2400MT/s, and 2666MT/s, and 2933MT/s

Available Memory Configurations:

	Single Processor												
						CP	U O						
System			Top :	Slots					Botton	n Slots			
Memory	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	DIMM 9	DIMM 10	DIMM 11		
8GB	8GB												
16GB	8GB												
24GB	8GB		8GB		8GB								
2250	8GB		8GB							8GB			
32GB	16GB												
4050	8GB		8GB		8GB			8GB		8GB			
48GB	16GB		16GB		16GB								
	16GB		16GB							16GB			
64GB	32GB												
	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB		
96GB	16GB		16GB		16GB			16GB		16GB			
	32GB		32GB		32GB								
128GB	32GB		32GB							32GB			
	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB		
192GB	32GB		32GB		32GB			32GB		32GB			
	32GB	32GB	32GB		32GB			32GB		32GB	32GB		
256GB	64GB		64GB							64GB			
	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB		
384GB	64GB		64GB		64GB			64GB		64GB			
512GB	64GB	64GB	64GB		64GB			64GB		64GB	64GB		
	64GB	64GB	64GB	64GB	64GB	64GB	64GB	64GB	64GB	64GB	64GB		
768 GB	128GB		128GB		128GB			128GB		128GB			
1.5 TB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB		

System Technical Specifications

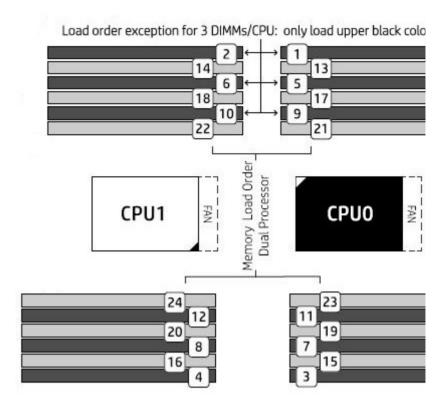
											Dual f	Processo	r Config	uration				
						С	PU 0											(
System			Тор	Slots			Bottom Slots					Top Slots						
Memory	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6	DIMM 7	DIMM 8	DIMM 9	DIMM 10	DIMM 11	DIMM 12	DIMM 1	DIMM 2	DIMM 3	DIMM 4	DIMM 5	DIMM 6
16GB	8GB												8GB					
32GB	8GB											8GB	8GB					
48GB	8GB		8GB		8GB								8GB		8GB		8GB	
	8GB		8GB							8GB		8GB	8GB		8GB			
64GB	16GB											16GB	16GB					
	8GB		8GB		8GB			8GB		8GB		8GB	8GB		8GB		8GB	
96GB	16GB		16GB		16GB								16GB		16GB		16GB	
	16GB		16GB							16GB		16GB	16GB		16GB			
128GB	32GB											32GB	32GB					
	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB	8GB						
192GB	16GB		16GB		16GB			16GB		16GB		16GB	16GB		16GB		16GB	
	32GB		32GB		32GB								32GB		32GB		32GB	
	32GB		32GB							32GB		32GB	32GB		32GB			
256GB	64GB											64GB	64GB					
	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB	16GB						
384GB	32GB		32GB		32GB			32GB		32GB		32GB	32GB		32GB		32GB	
	64GB		64GB		64GB								64GB		64GB		64GB	
512GB	64GB		64GB							64GB		64GB	64GB		64GB			
	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB	32GB						
768GB	64GB		64GB		64GB			64GB		64GB		64GB	64GB		64GB		64GB	
	128GB		128GB		128GB								128GB		128GB		128GB	
1TB	64GB	64GB	64GB		64GB			64GB		64GB	64GB	64GB	64GB	64GB	64GB		64GB	
4	64GB	64GB	64GB	64GB	64GB	64GB	64GB	64GB	64GB	64GB	64GB	64GB						
1.5TB	128GB		128GB		128GB			128GB		128GB		128GB	128GB		128GB		128GB	
зтв	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB	128GB						

Memory Loading Order:

Load Order for Single and Dual Processor Configuration



System Technical Specifications



Maximum Memory

Supports up to 1.5TB with two processors, using RDIMMs Supports up to 3TB with two processors, using 3DS LR DIMMs $\,$

Memory Configuration (Supported)

Only ECC Registered DIMMs are supported.

- RDIMM (Registered) ,LR DIMM (Load Reduction) and 3DS LR DIMM (3D Stac mixed. All memory installed in the system must be either RDIMM , LR DIMM or
- Do not install memory modules into memory slots if corresponding processor in the proc
- Dual processor configurations with memory modules installed for only one pro-

Notes

For systems installed with Microsoft Windows 7 (Ultimate, Enterprise or Pro), the maximum access

- Sleep (S3 state) support:
- Sleep (S3 state) may not be supported with non-HP validated and qualified 64 GB LR DIMMs.
- Sleep (S3 state) not supported with 128 GB LR DIMMs

NVDIMM Memory

Intel® OptaneTM DC Persistent Memory is available factory configured in the following capacities:

- 128GB (1x128GB) Single Processor Configuration
- 256GB (2x128GB) Single Processor Configuration
- 512GB (4x128GB) Dual Processor Configuration

NOTES:

- 1. Supported only with Xeon 82xx, 62xx, 52xx and 4215 processors.
 - a. Available as factory configured in Memory Mode or Storage Mode.
 - i. Microsoft Configured Memory Mode will be available in CQ1 2020
 - Systems configured with DCPMM memory will operate the memory subsystem at 2666 MT

System Technical Specifications

- c. Operating System Support:
 - i. Windows 10 Pro 64 for Workstations v1903 or later with all updates applied.
 - ii. Linux OS support may be found in the Linux Hardware Support Matrix.
- d. Detailed setup, security and support information may be found in the Intel® Optane DC Po G4 and Z8 G4 Workstation white paper.
- e. DCPMM solutions require additional DRAM memory to be included in the solution:
 - i. Systems configured with DCPMM in Memory Mode will include DRAM memory to be used based on an 8:1 DCPMM to DRAM capacity ratio.
 - ii. Systems configured with DCPMM in Storage Mode will require DRAM System Memory to
 - iii. DCPMM Memory will report approximately 2% less than advertised capacity.
- f. Total Memory (DCPMM + DRAM) per processor must be <= 1TB or 2TB per dual processor sy
 - i. Z8 G4 Note: "M"? processors support a total memory limit < =2TB per processors or 4T
- 2. Option Kit available in CQ1-2020.
- 3. Requires 2nd processor option.

PCI Express Connectors

Two PCIe Gen3 x16 with latch
Two PCIe Gen3 x16 with latch.

• Enabled only with optional 2nd CPU is installed.

One PCIe Gen3 x8 open-ended connector.

- Enabled for One PCIe Gen2 x4 slot with 1 CPU
- Enabled for One PCIe Gen3 x8 with optional 2nd CPU installed

Two PCIe Gen3 x4 open-ended connectors

Supported Drive Interfaces

SATA 2 sSATA @6Gb/s, supports RAID 0, 1.

8 SATA @6Gb/s, supports RAID 0, 1, 5, 10.

Factory integrated Intel® SATA RAID is Microsoft Windows only.

External SATA (eSATA)* Supported on all SATA and sSATA ports configurable with option

* hot plug / hot swap not supported with eSATA

Factory Configured RAID SATA: RAID 0, 1, 10

Network Controller

Integrated Intel I219LM Memory Integrated 3KB receive buffer and 3KB transmit buffer

Data rates supported: 10/100/1000 Mb/s

Compliance IEEE 802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab,

Up to 32 programmable filters

Bus architecture PCIe 1.0 x1 and SMBus UEFI and PXE Boot ROM support

Network transfer rates:

10BASE-T (half-duplex) 10 Mb/s 10BASE-T (full-duplex) 20 Mb/s 100BASE-TX (half-duplex) 100 Mb/s 100BASE-TX (full-duplex) 200 Mb/s 1000BASE-T (full-duplex) 2000 Mb/s

Management capabilities: WOL (All Power States, including Max | Advanced cable diagnostics, AMT 11.2x support, vPro compliant

Integrated Intel X722 for 1GbE Data rates supported: 1000 Mb/s

Compliance IEEE 802.1as/1588v2, 802.1p, 802.1Q, 802.3, 802.3a

Up to 16 UDP/TCP programmable filters

Bus architecture: PCle 3.0

System Technical Specifications

UEFI and PXE Boot ROM support Intel iWARP Support (RDMA) Network transfer rates:

1000BASE-T (full-duplex) 2000 Mb/s

Management capabilities: WOL (Excluding Max Power Savings), a

Advanced cable diagnostics

Integrated Graphics None **PCI-X Connectors** None **PCI Card Guide** Yes

Wake on LAN Yes, both ports

Integrated Trusted Platform

Module

Trusted Platform Module (TPM) 2.0 (Infineon SLB 9670)

Common Criteria EAL4+ Certified

FIPS 140-2 Certified TPM Certified products list:

https://trustedcomputinggroup.org/membership/certification/tpm-certified-products/

CG TPM Certified products list:

http://www.trustedcomputinggroup.org/certification/tpm-certified-products/

IEEE 1394 Connector(s) **Front** None

> Rear None Internal None

USB Connector(s) Front I/O Entry: 4 USB 3.1 Gen1 (Left-most Port has Charging Ca) Front

Front I/O Premium: 2x USB 3.1 Gen1, 2x USB 3.1 Gen2 Type-CTM (

 Charging Ports provide 1.5 Amps @ 5 Volts Standard USB Type A Ports provide 900mA @ 5

USB Type C Ports provide 3 Amps @ 5 Volts

6 USB 3.1 Gen1, Type A Rear

Internal 1 USB 3.1 Gen1 available with a single 12-pin shrouded connecto

> 1 USB 2.0 single-port header 1x USB 2.0 dual-port header

HD Integrated Audio

Realtek ALC221

Flash ROM

Yes

Yes

CPU Fan Header

Two headers for CPU fans

Memory Fan Header

Two headers

Chassis Fan Header

One Rear Chassis Fan Header

Front PCI Fan Header

One Front and one Aux Fan Header

Front User Interface

Power Button; Power and HDD Activity LEDs; Power for USB Ports

Header

Front Audio Header

FIO Headset/Mic and Speaker

CMOS Battery Holder -

Lithium

Power Supply Headers Yes **Clear Password Jumper** Yes

Serial Port Yes, on rear panel

Parallel Port No **Keyboard/Mouse** Yes

System Technical Specifications

Power Supply 1125W/1275W*/1450W* 90% Efficient, Custom PSU

(Wide-Ranging, Active PFC) 90-269 VAC

Operating Voltage Range

Rated Voltage Range

Rated Line Frequency

Operating Line Frequency Range

Rated Input Current

Heat Dissipation (Configuration and software

dependent)

Power Supply Fan
ENERGY STAR Qualified
(Configuration dependent)

Power Supply Efficiency

100-127 VAC 200-240 VAC

50-60 Hz

47-66 Hz

118 VAC

400 Hz

393-407 Hz

12A @ 100-127 VAC 10A @ 200-240 VAC 12A @ 118 VAC

16A @ 1 10A @ 2

100

200

5(

4

Typical = 2419 btu/hr Max 1 = 4626 btu/hr Max 2 = 5001 btu/hr Max 3 = 5560 btu/hr

(2) Blowers variable speed

Yes

90% Efficient

The Z8 G4 1125W (1450W at 200V Input Voltage) power supply efficiency report can be found at this link: https://plugloadsolutions.com/psu/reports/HP%20Inc_DPS-

ps://plugloadsolutions.com/psu_reports/HP%20Inc_DF 1125BB%20A_1125W_ECOS%204825_Report.pdf The Z8 G4 supply

https://plugle 1450AB

FEMP Standby Power Compliant @115V (<2W in S5 -

Power Off)

EuP Compliant @ 230V

(<0.5 W in S5 - Power Off)

CECP Compliant @ 220V

(<4W in S3 - Suspend to RAM)

Power Consumption in sleep mode

(as defined by ENERGY STAR) - Suspend to RAM (S3)

(Instantly Available PC)

Built-in Self-Test LED

Surge Tolerant Full Ranging Power Supply

(withstands power surges up to 2000V)

Yes

Yes

Yes; Configuration dependent

TBD

Yes

Yes

*Input voltage restriction

NOTE: The 1125W (1450W at 200V Input Voltage) power supply can also sup greater than 105V. If the input voltage is less than 105V, but greater than 90 drawn is 1125W. An uninterruptible power supply (UPS) is highly recommen The 1125W Power Supply can also supply 1450W of output power when the conditions.

NOTE: The 1450W (1700W at 200V Input Voltage) power supply can also sup greater than 105V. If the input voltage is less than 105V, but greater than 90 drawn is 1450W. An uninterruptible power supply (UPS) is highly recommen

The 1450W Power Supply can also supply 1700W of output power when the 180V under all conditions.

AUX IN (audio)
Clear CMOS Button

No Yes

System Technical Specifications

Multibay Header No

Integrated Gigabit Ethernet Yes, dual port.

Access Panel Solenoid Lock Header

Access Panel Intrusion Sensor Header Yes, as part of Front UI (Control Panel) cable header

Memory Fan Connector Yes, blind-mate

System Configurations

Example Z8 G4	Processor Info	1x Intel Xeon	3106 1.7 2133	8C 85 1stCPII				
Configuration #1	Memory Info		16GB DDR4-2666 (2x8GB) RegRAM CPU1					
	Graphics Info		x NVIDIA Quadro P600					
	Disks/Optical/Floppy		TA 1st SSD /1x l	DVD_DOM SAT	- _^			
	Power Supply	1125W 90% (DVD-ROM SAI	А			
		1123W 90%	Lustoiii P30					
	Other	-	- VAC	226		100		
			5 VAC	i	VAC		VAC	
Energy Consumption	W" - 1 (CO)	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	
	Windows Idle (S0)		5.4	1	1.8	75.7		
	Windows Busy Typ(S0)	122.04 111.9 1			11	113.6		
	Windows Busy Max (S0)	125.4		124.6		126.6		
	Sleep (S3)	6.22	6.26	6.26	6.26	6.33	6.25	
	Off (S5)	4.23	4.19	4.19	4.16	4.13	4.12	
	Zero Power Mode (ErP)	0	.31	0.40		0.29		
				1		1		
		11	5 VAC	230	VAC	100	VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
(Btu/hr)	Windows Idle (S0)	257.5		255.3		258.5		
	Windows Busy Typ(S0)	416.4 382.0		2.0	387.6			
	Windows Busy Max (S0)	4:	427.9 425.1		5.1	432.0		
	Sleep (S3)	21.2	21.1	21.3	21.2	21.6	21.3	
	Off (S5)	14.4	14.0	14.3	14.2	14.1	14.1	
	Zero Power Mode (ErP)	1	.04	1.38		0.99		

F	Dua sa sa sa sa la fa	To 1.17 44440 00400 405 004 4500					
Example Z8 G4	Processor Info	i	2x Intel Xeon 4114 2.2 2400 10C 85 1stCPU				
Configuration #2	Memory Info	48GB DDR4-2	18GB DDR4-2666 (6x8GB) RegRAM CPU2				
	Graphics Info	1x NVIDIA Qua	adro P2000				
	Disks/Optical/Floppy	4x 512GB SA	TA 1st SSD /1x	DVD-ROM SAT	`A		
	Power Supply	1125W 90% (Custom PSU				
	Other	_					
		115 VAC 230 VAC 100 VAC			VAC		
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled
Energy Consumption	Windows Idle (S0)	10	105.2 103.3		3.3	102.5	
	Windows Busy Typ(S0)	25	57.4	246.3		260.9	
	Windows Busy Max (S0)	29	96.2	289.9		297.6	
	Sleep (S3)	8.46	8.35	8.57	8.45	8.58	8.57
	Off (S5)	4.15	4.14	4.31	4.19	4.21	4.15
	Zero Power Mode (ErP)	0	.31	0.40		0.29	
		115 VAC		230	VAC	100 VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
(Btu/hr)	Windows Idle (S0)	359.0		352.5		349.8	

System Technical Specifications

Windows Busy Typ(S0)	878.3		84	0.5	890.2	
Windows Busy Max (S0)	1010.7		989.1		1015.6	
Sleep (S3)	28.8	28.5	29.2	28.8	29.2	29.2
Off (S5)	14.1	14.1	14.6	14.2	14.3	14.1
Zero Power Mode (ErP)	1.04		1.36		0.99	

Example Z8 G4	Processor Info	2x Intel Xeon	2x Intel Xeon 5120 2.2 2400 14C 105 1stCPU				
Configuration #3	Memory Info	96GB DDR4-2	96GB DDR4-2666 (12x8GB) RegRAM CPU2				
	Graphics Info	1x NVIDIA Qu	Ix NVIDIA Quadro P4000				
	Disks/Optical/Floppy	4x 2TB 7200	RPM SATA 1st I	HDD /1x DVDR	W SATA		
	Power Supply	1125W 90% (Custom PSU				
	Other	-					
		11!	5 VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled
Energy Consumption	Windows Idle (S0)	12	25.7	12	3.6	12	5.8
	Windows Busy Typ(S0)	340.7		332.9		343.7	
	Windows Busy Max (S0)	417.1		411.8		426.1	
	Sleep (S3)	9.28	9.10	9.24	9.15	9.49	9.26
	Off (S5)	4.15	4.14	4.32	4.10	4.21	4.16
	Zero Power Mode (ErP)	0	.31	0.41		0.30	
				1			
		11!	5 VAC	230	VAC	100	VAC
Heat Dissinction		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
Heat Dissipation	Windows Idle (S0)	429.3 422.0		42	9.5		
(Btu/hr)	Windows Busy Typ(S0)			1136.0		117	72.9
(200,,	Windows Busy Max (S0)			1405.3		1453.9	
	Sleep (S3)	31.6	31.0	31.5	31.2	32.4	31.5
	Off (S5)	14.1	14.1	14.7	13.9	14.3	14.2
	Zero Power Mode (ErP)	1	.05	1.38		1.03	

Example Z8 G4	Processor Info	2x Intel Xeon	2x Intel Xeon 6152 2.1 2666 22C 140 CPU				
Configuration #4	Memory Info	192GB DDR4-	192GB DDR4-2666 (24x8GB) RegRAM CPU				
	Graphics Info	2x NVIDIA Qua	dro P5000	_			
	Disks/Optical/Floppy	6x 1 TB SATA	SSD /1x DV	DRW SATA			
	Power Supply	1125W 90% C	ustom PSU				
	Other	-					
		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled
Energy Consumption	Windows Idle (S0)	16 ⁻	1.1	15	7.8	160.4	
	Windows Busy Typ(S0)	524	524.7 500.7		49	496.1	
	Windows Busy Max (S0)	644.2 624.2		652.7			
	Sleep (S3)	10.3	10.2	10.2	10.1	10.1	10.1
	Off (S5)	4.14	4.01	4.19	4.19	4.16	4.15
	Zero Power Mode (ErP)	0.3	31	0.	41	0.31	
		115	VAC	230	VAC	100	VAC
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled
(Btu/hr)	Windows Idle (S0)	549			8.4		7.5
	Windows Busy Typ(S0)	179	1790.4 1708.6		08.6	1692.6	
	Windows Busy Max (S0)	219	8.1	2129.8		222	27.0
	Sleep (S3)	35.3	34.9	35.0	34.7	34.5	134.3
	Off (S5)	14.1	13.6	14.3	14.3	14.2	14.1

System Technical Specifications

Zero Power Mode (FrP)	1 06	1 20	1 0/1
IZEIU EUWEI MUUE (EIE)	מט.ו	1.33	1.04

Example Z8 G4	Processor Info	2x Intel Xeon	6136 3.0 2666	5 12C 150 CPU				
Configuration #5	Memory Info	768GB DDR4-	68GB DDR4-2666 (24x32GB) RegRAM CPU2					
	Graphics Info	2x NVIDIA Qua	x NVIDIA Quadro P6000					
	Disks/Optical/Floppy	HP Z Turbo Q	uad Pro 4x1T	B + 4x 1 TB SA	TA SSD /1x D	VDRW SATA		
	Power Supply	1450W 90% C	ustom PSU					
	Other	_						
		115	VAC	230	VAC	100	VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	
Energy Consumption	Windows Idle (S0)	194	4.0	19	2.6	197.0		
	Windows Busy Typ(S0)	64	0.2	622.0 647.0			7.0	
	Windows Busy Max (S0)	78	788.0 761.3		800.6			
	Sleep (S3)	21.1	19.7	19.7	18.8	21.3	19.8	
	Off (S5)	4.24	4.22	4.53	4.51	4.24	4.21	
		Y						
		115	VAC	230	VAC	100	VAC	
Heat Dissipation		LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Disabled	LAN Enabled	
(Btu/hr)	Windows Idle (S0)	66	662.1 657.2 2184.3 2122.3		7.2	67	2.3	
	Windows Busy Typ(S0)	218			22.3	220	07.7	
	Windows Busy Max (S0)	268	8.8	2597.8		273	31.7	
	Sleep (S3)	72.3	67.5	67.5	64.1	72.6	67.7	
	Off (S5)	14.4	14.4	15.4	15.4	14.4	14.3	

NOTE: Power consumption measurements do not take advantage of the Intel Turbo Boost Technology. As a result, power consumption measurements may be higher.

Declared Noise Emissions

System Configuration (Entry level)	Processor Info	2-Intel® Xeon® Gold 6134 pro
	Memory Info	96GB (12x8GB) DDR4-2666
	Graphics Info	1-NVIDIA® Quadro
	Disks/Optical	1-500GB SATA 7200RPM 3.5"? HDD / 1-
	Power Supply	1125 V

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.6	19
	Hard drive Operating	3.7	19
	(random reads)		



System Technical Specifications

System Configuration (Mid-range)	Processor Info	2-Intel® Xeon® Gold 6146 pro
	Memory Info	384GB (24x16GB) DDR4-266
	Graphics Info	1-NVIDIA® Quadro®
	Disks/Optical	2-300GB 12Gb/s 15KRPM SAS HDD / 1-I
	Power Supply	1450 V

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.6	20
	Hard drive Operating	3.8	23
	(random reads)		

Environmental Data

Requirements

Environmental Temperature Operating: 5° to 35° C (40° to 95° F)

Non-operating: -40° to 60° C (-40° to 140° F)

Humidity Operating: 8% to 85% RH, non-condensing

Non-operating: 8% to 90% RH, non-condensing

Maximum Altitude Operating: 3,048 m (10,000 feet)

Non-operating: 9,144 m (30,000 feet)

Dynamic (new) Shock

Operating: ?-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ?-sine: 160 cm/s, 2-3ms (~105g)

square: 422 cm/s, 20g

NOTE: Values represent individual shock events and do not indicate repetitive

shock events.

Vibration

Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g?/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g?/Hz

NOTE: Values do not indicate continuous vibration.

Cooling Above 1524 m (5,000 feet) altitude, the maximum operating temperature is

reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation, up

to 3048 m (10,000 feet)

Physical Security and Serviceability

Access Panel Tool-less

Includes system board and memory information.

Optical Drive Tool-less, 2nd Optical Drive requires a 5.25"? bay carrier

Hard DrivesTool-lessExpansion CardsTool-lessProcessor SocketTool-less

Blue User Touch Points Yes, on tool-free internal chassis components.

System Technical Specifications

Color-coordinated Cables Yes

and Connectors

Memory Tool-less

Tool-less, retained by Front Card Guide and Top Memory Fan Holder **System Board**

Dual Color Power and HD LED on Front of Computer Configuration Record SW

Yes

Over-Temp Warning on

Screen

Yes. Temp-Caution and Temp Critical are provide via the WMI interface. Tools like the HPPA can display

the Critical and Caution state.

Restore CD/DVD Set Restores the computer to its original factory shipping image; can be obtained via HP Support.

Dual Function Front

Power Switch

Yes, causes a fail-safe power off when held for 4 seconds

Padlock Support

Cable Lock Support Yes, Kensington Cable Lock (optional): Prevents entire system theft only. 3mm x 7mm slot at rear of

system

Universal Chassis Clamp

Lock Support

Solenoid Lock and Hood

Sensor

No

No

Rear Port Control Cover No

Serial, USB,

Yes. USB disablement zones are Front, Rear and Internal

Audio, Network, **Enable/Disable Port**

Control

Removable Media

Write/Boot Control

Power-On Password

Yes, prevents an unauthorized person from booting up the workstation

Setup Password

Yes, prevents an unauthorized person from changing the workstation configuration

3.3V Aux Power LED on

System PCA

Yes

No

NIC LEDs (integrated)

(Green & Amber) **CPUs and Heatsinks**

A torx driver (T30) is needed to remove the heatsink(s). CPU attached to heatsink via tool-less clip

Power Supply Diagnostic

Yes

Front Power Button

Front Power LED Yes, white (normal), red (fault)

Yes

Yes, white

Front Hard Drive Activity

LED

Front ODD Activity LED Yes

System/Emergency ROM

Flash Recovery

Internal Speaker

Recovers corrupted system BIOS

Cooling Solutions

Air cooled forced convection 2x - Dual Side Inlet Blowers

Power Supply Fans CPU Heatsink Fan

80mm x 25mm 5-wire PWM for each CPU

Chassis Fan

Rear: 120mm x 38mm

Front: 120mm x 25mm (PCIe zone)

System Technical Specifications

Memory Heatsink Fan Front 92mm x 25mm (upper memory bank); Front 80mm x 25mm (lower memory bank)

HP PC Hardware Diagnostics UEFI HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing ESC then F2 upon the PC reboot, and is available

as a download from HP Support.

Access Panel Key Lock Yes, prevents removal of the access panel and all internal components including optical and storage

devices

ACPI-Ready Hardware Advanced Configuration and Power Management Interface (ACPI).

Allows the system to wake from a low-power mode.

 Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system

Trusted Platform Module

Chip

Yes, front and rear

Integrated Chassis Handles **Power Supply**

PCIe Card Retention

Tool-less, rear access direct-connect (blind-mate) Yes. tool-less

Rear (all)

Middle (full-height cards)

Front (full-length cards with extenders)

Yes.SPI ROM Flash ROM

Diagnostic Power Switch

LED on board

Yes

Clear Password Jumper Yes **Clear CMOS Button** Yes **CMOS Battery Holder** Yes **DIMM Connectors** Yes

BIOS

BIOS 32-bit Services Standard BIOS 32-bit Service Directory Proposal v0.4

BIOS supports 32 and 64-bit Operating systems.

PCI 3.0 Support Full BIOS support for PCI Express through industry standard interfaces.

ATAPI ATAPI Removable Media Device BIOS Specification Version 1.0.

BBS BIOS Boot Specification v1.01.

WMI Support WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is

fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and

WBEM specifications.

BIOS Boot Spec 1.01+ Provides more control over how and from what devices the workstation will boot.

BIOS Power On Users can define a specific date and time for the system to power on.

ROM Based Computer Setup Utility (F10)

Replicated Setup

Review and customize system configuration settings controlled by the BIOS.

System/Emergency ROM Recovers system BIOS in corrupted Flash ROM.

Flash Recovery with Video

Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigurationUtility.exe

utility can then replicate these settings on machines being deployed without entering Computer

Configuration Utility (F10 Setup).

SMBIOS System Management BIOS 2.8, for system management information. **Boot Control** Disables the ability to boot from removable media on supported devices.

Memory Change Alert Alerts management console if memory is removed or changed.

System Technical Specifications

Thermal Alert Monitors the temperature state within the chassis. Three modes:

• NORMAL - normal temperature ranges.

ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown

or provide for a smoother system shutdown.

• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without

warning before hardware component damage occurs.

Remote ROM Flash Provides secure, fail-safe ROM image management from a central network console. **ACPI (Advanced** Allows the system to enter and resume from low power modes (sleep states).

Configuration and Power Management Interface)

Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without

affecting other elements of the system.

Supports ACPI 5.0 for full compatibility with 64-bit operating systems.

Ownership Tag

A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.

Shutdown

Remote Wakeup/Remote System administrators can power on, restart, and power off a client computer from a remote location.

Instantly Available PC (Suspend to RAM - ACPI sleep state S3)

Allows for very low power consumption with quick resume time.

Remote System

Installation via F12 (PXE

Allows a new or existing system to boot over the network and download software, including the operating system.

2.1) (Remote Boot from Server)

ROM revision levels

Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW applications can use

and report this information.

System board revision

level

Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.

Start-up Diagnostics (Power-on Self-Test) Assesses system health at boot time with selectable levels of testing.

Auto Setup when new hardware installed

System automatically detects addition of new hardware.

Keyboard-less Operation The system can be booted without a keyboard.

Localized ROM Setup

Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with local keyboard mappings.

Asset Tag

The user or MIS to set a unique tag string in non-volatile memory.

Per-slot Control Adaptive Cooling Pre-boot Diagnostics Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Control parameters are set according to detected hardware configuration for optimal acoustics.

(Pre-video) critical errors are reported via beeps and blinks on the power LED.

Industry Standard Specification Support

Industry Standard

Revision Supported by the BIOS

UEFI Specification

Revision

2.5

ACPI Advanced Configuration and Power Management Interface, Version 5.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b **CD Boot** "El Torito" Bootable CD-ROM Format Specification Version 1.0

- Enhanced Disk Drive Specification Version 1.1 **EDD**

- BIOS Enhanced Disk Drive Specification Version 3.0

EHCI Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0

PCI PCI Local Bus Specification, Revision 2.3

> PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7

PCI Express PCI Express Base Specification, Revision 2.0

PCI Express Base Specification, Revision 3.0

System Technical Specifications

PMM POST Memory Manager Specification, Version 1.01

SATA Serial ATA Specification, Revision 1.0a

Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0

SPD PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B

TPM Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9670).

Common Criteria EAL4+ certified.

FIPS 140-2 Certification

TCG TPM Certified products list:

http://www.trustedcomputinggroup.org/certification/tpm-certified-products/

UHCI Universal Host Controller Interface Design Guide, Revision 1.1

USB Universal Serial Bus Revision 1.1 Specification

Universal Serial Bus Revision 2.0 Specification

Universal Serial Bus Revision 3.1 Specification

SMBIOS System Management BIOS Reference Specification, Version 2.8

External BIOS simulator found at: http://csrsml.itcs.hp.com/

Social and Environmental Responsibility

Eco-Label Certifications & Declarations

Batteries

This product has received or is in the process of being certified to the following approvals and ma

- ENERGY STAR® (energy-saving features available on selected configurations-Windows only
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- The ECO declaration (TED)

The Z8 G4 is registered EPEAT® Gold in the US and Canada. EPEAT® registration varies by country country. Search keyword generator on HP's 3rd party option store for solar generator accessorie

The battery in this product complies with EU Directive 2006/66/EC

Battery size: CR2032 (coin cell)

Battery mass: 3g

Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

Restricted Material Usage

This product meets the material restrictions specified in HP's General Specification for the Enviro HP Inc. is committed to compliance with all applicable environmental laws and regulations, inclus Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requir

Low Halogen Statement

End-of-Life Management and Recycling

HP Inc. Corporate Environmental Information

This product is low-halogen except for power cords, external cables and peripherals. The followinot be low-halogen: 3 ?" SAS HDDs. Service parts obtained after purchase may not be low-haloge HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will manner. This product is greater than 90% recyclable by weight when properly disposed of at end

For more information about HP's commitment to the environment:

Sustainability Report

Eco-label certifications: http://www.hp.com/hpinfo/globalcitizenship/environment/productdesig ISO 14001 certificate: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/env



System Technical Specifications

Additional Information

Packaging

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment Instructions
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and IS
- This product is >90% recycle-able when properly disposed of at end of life.

HP Workstation product packaging meets the HP's General Specification for the Environment

- Does not contain restricted substances listed in HP Standard 011-1 General Specification f
- Does not contain ozone-depleting substances (ODS)
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in exces
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards fo
- A multi-unit eco packaging option is available to institutional customers that uses less pac conventional single-unit packaging. Please contact your sales representative for additiona

Packaging Materials Internal

External

Cushions and plastic bags made of low density polyethylene (LDPE).

Outer carton, accessories carton, and insert made of corrugated paper board.

Specifications

This product meets the following industry standard specifications for manageability functionality:

• DASH 1.1 (via Intel® LAN on motherboard)

Intel® Active Management Intel® Active Management Technology (AMT) 11.2x Technology (AMT)

> An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 11.2x includes the following advanced management functions:

- Power Management (on, off, reset, graceful shutdown, sleep and hibernate)
 - O Support in Max Power Savings (Shutdown and Hibernate Modes)
- Hardware Inventory (includes BIOS and firmware revisions)
- Hardware Alerting
- Agent Presence
- System Defense Filters
- Serial Over LAN (SOL)
- USB Redirect (Media Redirection)
- ME Wake-on-LAN (WOL), even with Maximum Power Savings Enabled
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the system connects to the IT or service provider console for maintenance.
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Local Time Sync to UTC
- Remote Memory Dump Command Creates memory dump for debug

Manageability

Industry Standard

System Technical Specifications

Intel® vProTM Technology The HP Z8 G4 Workstation supports Intel® vProTM technology when configured as outlined below:

- Intel® Xeon® processor E5-1600 v5 or E5-2600 v5 product family featuring Intel® vProTM Technology
- Intel® C622 chipset
- Intel® I219LM GbE LAN

Remote Manageability Software Solutions

The HP Z8 G4 Workstation is supported on the following remote manageability software consoles:

- LANDesk Management Suite (HP recommended solution)
- Microsoft System Center Configuration Manager
- HP Client Automation Enterprise

Service, Support, and Warrantv

For questions or support for manageability needs, please visit http://www.hp.com/go/clientmanagement System Software Manager For questions or support for SSM, please visit: http://www.hp.com/go/ssm

> On-site Warranty and Service (Note 1): Three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am -5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services are extended service contracts that go beyond the standard limited warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at: http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

Product Change Notification

- Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.

Stable & Consistent Offerings

Global Series SKUs

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

Stable & Consistent Offerings

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors

Product #	Offering
2DL76AV	Intel® Xeon® Gold 6128 processor
2DL77AV / 1XM69AA	Intel® Xeon® Gold 6128 2 nd processor
2DL66AV	Intel® Xeon® Silver 4114 processor
2DL67AV / 1XM74AA	Intel® Xeon® Silver 4114 2 nd processor
2DL62AV	Intel® Xeon® Silver 4108 processor
2DL63AV / 1XM76AA	Intel® Xeon® Silver 4108 2 nd processor

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Product # Offering

Z5J60AV / LQ037AA 1TB SATA 7200 RPM 3.5"? HDD

Graphics

Product # 2TF08AA

Offering

AMD RadeonTM Pro WX 3100 4GB Graphics

Memory

Product #

Offering

TBD

TBD

Optical and Removable Storage

Product #

Offering

TBD

TBD

Technical Specifications - Processors

Intel® Xeon® Platinum 8280 processor
Intel® Xeon® Platinum 8260M processo
Intel® Xeon® Platinum 8260 processor
Intel® Xeon® Platinum 8180 processor
Intel® Xeon® Platinum 8160M processo
Intel® Xeon® Platinum 8160 processor
Intel® Xeon® Gold 6258R processor
Intel® Xeon® Gold 6254 processor
Intel® Xeon® Gold 6252 processor
Intel® Xeon® Gold 6248R processor
Intel® Xeon® Gold 6248 processor
Intel® Xeon® Gold 6246R processor
Intel® Xeon® Gold 6246 processor
Intel® Xeon® Gold 6244 processor
Intel® Xeon® Gold 6242R processor
Intel® Xeon® Gold 6242 processor
Intel® Xeon® Gold 6240R processor
Intel® Xeon® Gold 6240Y processor
Intel® Xeon® Gold 6240 processor
Intel® Xeon® Gold 6238R processor
Intel® Xeon® Gold 6230R processor
-
Intel® Xeon® Gold 6230 processor
Intel® Xeon® Gold 6226R processor
Intel® Xeon® Gold 6226 processor
Intel® Xeon® Gold 6152 processor
Intel® Xeon® Gold 6154 processor
Intel® Xeon® Gold 6148 processor
Intel® Xeon® Gold 6146 processor
Intel® Xeon® Gold 6144 processor
Intel® Xeon® Gold 6142M processor
Intel® Xeon® Gold 6142 processor
Intel® Xeon® Gold 6140M processor
Intel® Xeon® Gold 6140 processor
Intel® Xeon® Gold 6138 processor
Intel® Xeon® Gold 6136 processor
Intel® Xeon® Gold 6134M processor
Intel® Xeon® Gold 6134 processor
Intel® Xeon® Gold 6132 processor
Intel® Xeon® Gold 6130 processor
Intel® Xeon® Gold 6128 processor
Intel® Xeon® Gold 5222 processor
Intel® Xeon® Gold 5220R processor
Intel® Xeon® Gold 5220 processor
Intel® Xeon® Gold 5218R processor
Intel® Xeon® Gold 5218 processor
ווונבנ אבטוו שטנע שב וס מוטנצששטו

Intel® Xeon® Gold 5215M processor

Technical Specifications - Processors

Intel® Xeon® Gold 5215 processor

Intel® Xeon® Gold 5120 processor

Intel® Xeon® Gold 5118 processor

Intel® Xeon® Gold 5122 processor

Intel® Xeon® Gold 4216 processor

Intel® Xeon® Gold 4215R processor

Intel® Xeon® Gold 4215 processor

Intel® Xeon® Gold 4214R processor

Intel® Xeon® Gold 4214Y processor

Intel® Xeon® Gold 4214 processor

Intel® Xeon® Gold 4210R processor

Intel® Xeon® Gold 4210 processor

Intel® Xeon® Gold 4208 processor

Intel® Xeon® Silver 4116 processor

Intel® Xeon® Silver 4114 processor

Intel® Xeon® Silver 4112 processor

Intel® Xeon® Silver 4110 processor

Intel® Xeon® Silver 4108 processor

Intel® Xeon® Bronze 3206R processor

Intel® Xeon® Gold 3204 processor

Intel® Xeon® Bronze 3106 processor

Intel® Xeon® Bronze 3104 processor

Technical Specifications - Hard Drives

Storage/Hard Drives

HP SAS (Serial Attached SCSI) Hard Drives for HP **Workstations**

HP 300GB SAS 15K SFF HDD

Capacity

300GB

Height 5.9 in: 15 cm

Width

Media Diameter

3.5 in; 8.9 cm

2.0ms *

3.5 in: 8.9 cm

2 ms*

11 ms*

21 ms*

Interface

12Gb/s SAS

Up to 1200 MB/s (SAS single port)*

Synchronous Transfer

Rate (Maximum)

128MB

Average

Buffer

Seek Time (typical reads,

includes controller overhead, including

settling)

Rotational Speed 15K rpm

Operating Temperature 41° to 131° F (5° to 55° C)

*Actual performance may vary.

SATA (Serial ATA) Hard **Drives for HP Workstations**

500GB SATA 7200 rpm 6Gb/s 3.5" HDD

500GB Capacity Height 1 in; 2.54 cm

Width **Media Diameter**

> **Physical Size** 4 in: 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s*

Single Track

Average

16MB

Seek Time (typical reads, includes controller overhead, including

Full Stroke settling)

Rotational Speed 7,200 rpm **Logical Blocks** 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

*Actual performance may vary.

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

1TB Capacity

Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600 MB/s*

Buffer 64MB Cache Adaptive

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2 ms*Average
Full Stroke11 ms*21 ms*

Rotational Speed 7,200 rpm

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD CMR

Capacity 2.0TB
Height 1 in; 2.54 cm

WidthMedia Diameter3.5 in; 8.9 cmPhysical Size4 in; 10.17 cm

Up to 600 MB/s*

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average1.0 ms*
11 ms*
18 ms*

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD SMR Capacity2.0TBHeight1 in; 2.02 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.16 cm

Up to 600 MB/s*

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer

Rate (Maximum)

Buffer 256MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track1.2 ms*Average
Pull Stroke12 ms*

Rotational Speed 7,200 rpm **Logical Blocks** 3,907,029,168

Operating Temperature 41° to 140° F (5° to 60° C)

^{*}Actual performance may vary.

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

Capacity 1TB **Protocol** SATA **Form Factor** 3.5" Controller **AHCI**

Reliability (MTBF) 2.0M hours **Rated Power On Hours** 8760/yr **Annualized Failure Rate** <0.62%

(based on Rated POH)

Rated for 24/7/365 YES

operation

Physical Size (Height) 1 in; 2.54 cm 4 in; 10.17 cm

Physical Size (Width) **Media Diameter** 3.5 in; 8.9 cm

Interface Serial ATA (6Gb/s). NCO enabled

Up to 600MB/s*

Synchronous Transfer

Rate (Maximum)

Buffer 128MB

Seek Time (typical reads, **Single Track** includes controller overhead, including settling)

Average 7.45ms* 14.2ms* **Full Stroke**

41° to 140° F (5° to 60° C) **Operating Temperature**

Performance Sequential Read up to 226MB/s*

Sequential Write up to 226MB/s*

0.32ms*

Enterprise Class Features High Reliability

*Actual performance may vary.

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

Capacity 4TB

0.275 in; 0.7 cm Height

Width **Media Diameter** 2.5 in; 6.36 cm

> **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

Up to 600MB/s*

Buffer 128MB

Seek Time (typical reads. **Single Track** 0.7ms* includes controller 8.5ms* **Average** overhead, including **Full Stroke** 15.7ms* settling)

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

*Actual performance may vary.

25ms (typical)*

QuickSpecs

Technical Specifications - Hard Drives

500GB SATA 7.2K SED SFF Capacity

HDD

500GB

Height 0.275 in; 0.7 cm

Width **Media Diameter** 2.5 in; 6.36 cm

> **Physical Size** 2.75 in; 6.99 cm

Interface Serial ATA (6Gb/s) **Synchronous Transfer** Up to 600MB/s*

Rate (Maximum)

Buffer 32MB

Seek Time (typical reads, **Single Track** 1ms* includes controller **Average** 4.2ms* overhead, including

Full Stroke settling)

Rotational Speed 7,200 rpm **Operating Temperature** 32° to 140° F (0° to 60° C)

*Actual performance may vary.

SATA SSDs for HP Workstations

HP 256GB SATA 6Gb/s SSD

Capacity 256GB **Protocol** SATA **Form Factor** 2.5" Controller **AHCI NAND Type** 3D TLC

Endurance 192TBW (TB Written)

Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in: 6.36 cm Interface SATA 6Gb/s **Synchronous Transfer** Up to 600MB/s*

Rate (Maximum)

Operating Temperature

32° to 158° F (0° to 70° C) **Performance**

Sequential Read 530MB/s (max)* **Sequential Write** 500MB/s (max)* 55K IOPS (max)* **Random Read**

Random Write 83K IOPS (max)*

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

HP 256GB SATA 6Gb/s SED Opal 2 SSD Capacity 256GB
Protocol SATA
Form Factor 2.5"
Controller AHCI
NAND Type 3D TLC

Endurance 192TBW (TB Written)

Reliability (MTTF)1.5M hoursPhysical Size (Height)0.28 in; 0.7 cmPhysical Size (Width)2.5 in; 6.36 cmInterface6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)*

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530MB/s*

Sequential Write 500 MB/s*
Random Read 55K IOPS*
Random Write 83K IOPS*

Self-Encrypting Drive

Support

OPAL 2

*Actual performance may vary.

HP 512GB SATA 6Gb/s SSD Capacity512GBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLC

Endurance 388TBW (TB Written)

Reliability (MTTF) 1.5M hours

Physical Size (Height) 0.28 in; 0.7 cm

Physical Size (Width) 2.5 in; 6.36 cm

Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)*

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530 MB/s*

Sequential Write 500 MB/s*
Random Read 95K IOPS*
Random Write 83K IOPS*

^{*}Actual performance may vary.



HP 512GB SATA SED SSD

Capacity 512GB **Protocol** SATA **Form Factor** 2.5" Controller **AHCI** 3D TLC **NAND Type**

388TBW (TB Written) **Endurance**

Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in: 6.36 cm Interface SATA 6Gb/s Up to 600MB/s*

Synchronous Transfer

Rate (Maximum)

32° to 158° F (0° to 70° C)

Operating Temperature Performance Sequential Read 530 MB/s*

> 500 MB/s* Sequential Write **Random Read** 95K IOPS* **Random Write** 83K IOPS*

Self-Encrypting Drive

Support

OPAL 1 and 2

*Actual performance may vary.

HP 1TB SATA 6Gb/s SSD

1TB Capacity **SATA Protocol Form Factor** 2.5" Controller **AHCI NAND Type** 3D TLC

Endurance 400TBW (TB Written)

Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)*

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530 MB/s*

> **Sequential Write** 500 MB/s* **Random Read** 95K IOPS* **Random Write** 83K IOPS*

^{*}Actual performance may vary.



HP 2TB SATA 6Gb/s SSD

Capacity2TBProtocolSATAForm Factor2.5"ControllerAHCINAND Type3D TLC

Endurance 400TBW (TB Written)

Reliability (MTTF) 1.5M hours

Physical Size (Height) 0.28 in; 0.7 cm

Physical Size (Width) 2.5 in; 6.36 cm

Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)*

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 530 MB/s*

Sequential Write 500 MB/s *
Random Read 95K IOPS*
Random Write 83K IOPS*

HP Enterprise Class 240GB SATA SSD

Capacity 240GB
Protocol SATA
Form Factor 2.5"
Controller AHCI
NAND Type 3D TLC

Endurance 2,200TBW (TB Written)

Reliability (MTTF) 2.0M hours
Physical Size (Height) 0.28 in; 0.7 cm
Physical Size (Width) 2.5 in; 6.36 cm
Interface 6Gb/s SATA
Synchronous Transfer Up to 600MB/s*
Rate (Maximum)

Operating Temperature

32° to 158° F (0° to 70° C)

Performance Sequential Read 540 MB/s*

Sequential Write 310 MB/s*
Random Read 93K IOPS*
Random Write 48K IOPS*

Enterprise Class Features High Endurance NAND

Power Loss Protection End-to-End Data Protection

^{*}Actual performance may vary.

^{*}Actual performance may vary.



HP Enterprise Class 480GB SATA SSD

Capacity 480GB **Protocol** SATA 2.5" **Form Factor** Controller **AHCI** 3D TLC **NAND Type**

4.400TBW (TB Written) **Endurance**

Reliability (MTTF) 2.0M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in: 6.36 cm Interface 6Gb/s SATA Up to 600MB/s*

Synchronous Transfer

Operating Temperature

Rate (Maximum)

32° to 158° F (0° to 70° C)

Performance Sequential Read 540 MB/s*

> Sequential Write 460 MB/s* **Random Read** 93K IOPS* **Random Write 74K IOPS***

Enterprise Class Features High Endurance NAND

Power Loss Protection End-to-End Data Protection

Value PCIe SSDs for **HP Workstations**

HP 256GB M.2 2280 SSD

Capacity 256GB **Protocol** PCle **Form Factor** M.2 NVMe Controller **NAND Type** 3D TLC 200TB **Endurance** Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3100 MB/s *

> **Sequential Write** 1400 MB/s * **Random Read** 200K IOPS *

Random Write 320K IOPS *

^{*}Actual performance may vary.

^{*}Actual performance may vary.

Technical Specifications - Hard Drives

HP 512GB M.2 2280 SSD

Capacity 512GB
Protocol PCIe
Form Factor M.2
Controller NVMe
NAND Type 3D TLC
Endurance 300TB
Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3400 MB/s*

Sequential Write 2500 MB/s*
Random Read 380K IOPS*
Random Write 430K IOPS*

HP 1TB M.2 2280 SSD

Capacity1TBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLCEndurance400TBReliability (MTTF)1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3400 MB/s*

Sequential Write 2500 MB/s*
Random Read 500K IOPS*
Random Write 440K IOPS*

Performance PCIe
SSDs for HP
Workstations

HP Z Turbo Drive Quad Pro 2x256GB PCIe SSD **Capacity** 512GB **Protocol** PCIe

Form Factor PCIe Card, Full Height PCIe Slot

ControllerNVMeNAND TypeTLCEndurance200TBReliability (MTBF)1.5M hours

Interface PCIe Gen3 x4 architecture
Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2200 MB/s*
Random Read 240K IOPS*
Random Write 480K IOPS*

^{*}Actual performance may vary.

^{*}Actual performance may vary.

^{*}Actual performance may vary.



HP Z Turbo Drive Quad Pro 2x512GB PCIe SSD Capacity 1TB Protocol PCIe

Form Factor PCIe Card, Full Height PCIe Slot

Controller NVMe
NAND Type 3D TLC
Endurance 300TB
Reliability (MTBF) 1.5M hours

InterfacePCIe Gen3 x4 architectureOperating Temperature32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 2900 MB/s*
Random Read 4600 K IOPS*
Random Write 500K IOPS*

HP Z Turbo Drive Quad Pro 2x1TB PCIe SSD Capacity 2TB Protocol PCle

Form Factor PCIe Card, Full Height PCIe Slot

Controller NVMe
NAND Type 3D TLC
Endurance 400TB

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*
Sequential Write 3000 MB/s*
Random Read 580K IOPS*
Random Write 500K IOPS*

HP Z Turbo Drive G2 256GB TLCSSD and 256GB SED TLC SSD Capacity256GBProtocolPCIeForm FactorM.2ControllerNVMeNAND TypeTLC

Endurance 200TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

OPAL 2

Sequential Write 2200 MB/s*
Random Read 240K IOPS*
Random Write 480K IOPS*

Self-Encrypting Drive

Support

^{*}Actual performance may vary.

^{*}Actual performance may vary.



*Actual performance may vary.

HP Z Turbo Drive G2 512GB SED SSD and 512GB SED TLC SSD Capacity512GBProtocolPCIeForm FactorM.2ControllerNVMeNAND TypeTLCSED SupportOPAL 2

Endurance 300TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 3000 MB/s*
Random Read 580K IOPS*
Random Write 500K IOPS*

HP Z Turbo Drive G2 1TB TLC SSD and 1TB SED TLC SSD Capacity1TBProtocolPCIeForm FactorM.2ControllerNVMeNAND Type3D TLCSED SupportOPAL 2

Endurance 400TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

Sequential Write 3000 MB/s MB/s*
Random Read 580K IOPS*
Random Write 500K IOPS*

^{*}Actual performance may vary.

^{*}Actual performance may vary.



HP Z Turbo Drive G2 2TB TLC SSD and 2TB SED TLC SSD

Capacity 2TB PCle **Protocol** Form Factor M.2 Controller NVMe NAND Type 3D TLC **SED Support** OPAL 2

Endurance 500TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3500 MB/s*

> Sequential Write 3000 MB/s* **Random Read 600K IOPS* Random Write 500K IOPS***

*Actual performance may vary.

HP Z Turbo Drive Ouad Pro 256GB SSD module

Capacity

256GB (one M.2 PCIe NVMe module)

PCI Express 3.0 x4 electrical x4 physical Interface

Operating Temperature 32° to 158° F (0° to 70° C)

HP Z Turbo Drive Quad Pro Capacity 512GB SSD module

512GB (one M.2 PCIe NVMe module)

PCI Express 3.0 x4 electrical x4 physical

32° to 158° F (0° to 70° C) **Operating Temperature**

HP Z Turbo Drive Quad Pro Capacity

1TB SSD module

Interface

1TB (one M.2 PCIe NVMe module)

Interface PCI Express 3.0 x4 electrical x4 physical

32° to 158° F (0° to 70° C) **Operating Temperature**

HP Z Turbo Drive Quad Pro Capacity

2TB SSD module

2TB (one M.2 PCIe NVMe module)

Interface PCI Express 3.0 x4 electrical x4 physical

32° to 158° F (0° to 70° C) **Operating Temperature**

HP Z Turbo Drive Dual Pro 256GB SSD

Capacity: 256GB (one M.2 PCIe NVMe module) Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Technical Specifications - Hard Drives

HP Z Turbo Drive Dual Pro 512GB SSD

Capacity: 512GB (one M.2 PCIe NVMe module)
Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

HP Z Turbo Drive Dual Pro 1TB SSD

Capacity: 1TB (one M.2 PCIe NVMe module)

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

HP Z Turbo Drive Dual Pro 2TB SSD

Capacity: 2TB (one M.2 PCIe NVMe module)
Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Intel® 905p Series AIC PCIe SSD Intel® 905p Series AIC 280GB PCIe SSD

Capacity 280GB Protocol PCIe

Form Factor PCIe Card, Half Height

Controller NVMe NVM Type 3DXPoint

Endurance 5.11 PBW (PB Written)

Reliability (MTBF) 1.6M hours

Operating Temperature 32° to 185° F (0° to 85° C)

Performance Sequential Read 2730 MB/s*

Sequential Write 2280 MB/s*
Random Read 587K IOPS*
Random Write 559K IOPS*

*Actual performance may vary.

Intel® 905p Series AIC 480GB PCIe SSD Capacity 480GB Protocol PCle

Form Factor PCIe Card, Half Height

Controller NVMe NVM Type 3DXPoint

Endurance 8.76 PBW (PB Written)

Reliability (MTBF) 1.6M hours

Operating Temperature 32° to 185° F (0° to 85° C)

Performance Sequential Read 2710 MB/s*

Sequential Write 2280 MB/s*
Random Read 582K IOPS*
Random Write 561K IOPS*

*Actual performance may vary.

Technical Specifications - Hard Drives

Intel® Optane™ DC Persistent Memory Intel® OptaneTM DC Persistent Memory 128GB Module Capacity128GBProtocolDDR-TForm FactorDDR4ControllerNVMeNVM Type3DXPoint

Endurance 292 PBW (256B Sequential Write) 91 PBW (64B Sequential Write)

Reliability (MTBF) 2M hours

Operating Temperature 32° to 185° F (0° to 85° C)

Performance Sequential Read 6800 MB/s*

Sequential Write 1850 MB/s*

^{*}Actual performance may vary.



Technical Specifications - Hard Drive Controllers

Hard Drive Controllers

MicroSemi 2100-4i4e 8port SAS 12Gb/s RAID Card

PCI Bus 8 lanes, PCI Express 3.0

RAID Levels Offers Integrated RAID (0, 1, and 10) **PCI Data Burst Transfer** Half Duplex x8, PCIe, 8000 MB/s

Rate

SAS Bandwidth Half Duplex 1200 MB/s per lane

PCI Card Type 3.3V Add-in Card 12 V ± 10% **PCI Voltage**

PCI Power 9.8W typical, Airflow min 200 LFM

Bracket Full height and low profile **Certification Level** PCI Express 3.0 compliant

SAS Processor MicroSemi Series 8 SAS Controller **Internal Connectors** One x4 internal mini-SASHD (SFF-8643) **External Connectors** One x4 external mini-SASHD (SFF-8644) 256 Non-RAID SAS/SATA devices

Maximum Number of SCSI

Devices

LED Indicators Connector for Drive Activity Light **Technical Specifications - Graphics**

Graphics

NVIDIA® Quadro® P400 2GB Graphics **Form Factor** Dimensions: 2.713"? H x 5.7"? L

Single Slot, Low Profile

Cooling: Active Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P400 Graphics Card

GP107 GPU

256 NVIDIA® CUDA® cores Max Power: 30 Watts

Bus Type PCI Express 3.0 x16

Memory Size: 2 GB GDDR5, 2000 MHz

Memory Interface: 64-bit Memory Bandwidth: 32 GB/s

Connectors 3mDP Outputs

Maximum Resolution DisplayPortTM 1.4:

- up to 3x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 3 mDP Connectors

Shading Architecture Full Microsoft DirectX® 12 Shader Model 5.1

Supported Graphics APIs OpenGL® 4.5

DirectX® 12 VulkanTM 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCLTM

Available Graphics

Drivers

Microsoft Windows 10 Microsoft Windows 8.1

Microsoft Windows 7

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Technical Specifications - Graphics

NVIDIA® Quadro® P600 2GB Graphics Form Factor Dimensions: 2.713"? H x 5.7"? L

Single Slot, Low Profile Cooling: Active Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P600 Graphics Card

GP107 GPU

384 NVIDIA® CUDA® cores Max Power: 40 Watts

Bus Type PCI Express 3.0 x16

Memory Size: 2 GB GDDR5, 2000 MHz

Memory Interface: 128-bit Memory Bandwidth: 64 GB/s

Connectors4mDP OutputsMaximum ResolutionDisplayPort TM 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz- supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 4 mDP Connectors

Shading Architecture Full Microsoft DirectX® 12 Shader Model 5.1

Supported Graphics APIs OpenGL® 4.5

DirectX® 12 VulkanTM 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCLTM

Available Graphics

Drivers

Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Technical Specifications - Graphics

NVIDIA® Quadro® P620 2GB Graphics Form Factor Dimensions: 2.713"? H x 5.7"? L

Single Slot, Low Profile Cooling: Active Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P620 Graphics Card

GP107 GPU 512 CUDA cores Max Power: 40 Watts

Bus Type PCI Express 3.0 x16

Memory Size: 2 GB GDDR5, 2000 MHz
Memory Interface: 128-bit

Memory Bandwidth: 64 GB/s

Connectors 4mDP Outputs * Maximum Resolution DisplayPortTM 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz- supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 4 mDP Connectors

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulkan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCL

Available Graphics

Drivers

Microsoft Windows 10 Microsoft Windows 7

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes *P620 only have mini-DisplayPortTM (mDP) video ports.

Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No adapters included

After market option kit:Two mDP-to-DP Adapters included

Additional mDP-to-DP Adapters are available as Factory Configuration or

Option Kit accessories:

- 2MY05AA - HP miniDP-to-DP Adapter Cables

- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

AMD FireProTM W2100 2GB Graphics

Form Factor Low Profile, half length (full-height bracket included)

Graphics Controller AMD FirePro TM W2100 professional graphics based on Oland GPU.

GPU: 320 Stream Processors organized into 5 Compute Units

GPU Frequency: 630Mhz

Power: 26W Cooling: Active

Technical Specifications - Graphics

Bus Type PCI Express® x8, Generation 3.0

Memory 2GB DDR3 memory

Memory Bandwidth: up to 28.8 GB/s

Memory Width: 128 bit

Connectors 2x DisplayPortTM 1.2 connectors

Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

Additional DisplayPortTM-to-VGA or DisplayPortTM-to-DVI adapters are

available as Factory Configuration or Option Kit accessories.

Maximum Resolution DisplayPortTM 1.2:

- up to 4096x2160 x 24 bpp @ 60Hz

Dual Link DVI(I) (requires adapter cable): - up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I)(requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz

VGA (requires adapter cable):

- up to 1920 x 1200 x 32 bpp @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component.

High bandwidth scaler for high quality up and downscaling.

Display Output 2 x DisplayPortTM 1.2a

Maximum number of displays: 2

Shading Architecture Shader Model 5.0

Supported Graphics APIs OpenCLTM 1.2, DirectX[®] 11.2/12, OpenGL[®] 4.4

OpenGL® 4.4 support with driver release 14.301.xxx

OpenCLTM 1.2 conformance expected with drive release 14.301.xxx

Available Graphics

Drivers

Windows 10 (64-bit) Windows 7 (64-bit)

Linux®

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Notes Depending on the card model, native DisplayPortTM connectors and/or

certified DisplayPortTM active or passive adapters to convert your monitor's native input to your card's DisplayPortTM or Mini-DisplayPortTM connector(s)

may be required. See www.amd.com/FireProTM for details.

Technical Specifications - Graphics

NVIDIA® Quadro® P1000 4GB Graphics Form Factor Dimensions:2.713"? H x 5.7"? L

Single Slot, Low Profile Cooling: Active Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P1000 Graphics Card

GP107-860 GPU

640 NVIDIA® CUDA® cores Max Power: 47 Watts

Bus Type PCI Express 3.0 x16

Memory Size: 4 GB GDDR5, 2500 MHz

Memory Interface: 128-bit memory interface Memory Bandwidth: 80 GB/s memory bandwidth

Connectors 4mDP Outputs **Maximum Resolution** DisplayPortTM 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 4 mDP Connectors

Shading Architecture Full Microsoft DirectX® 12 Shader Model 5.1

Supported Graphics APIs OpenGL® 4.5

DirectX® 12 VulkanTM 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCLTM

Available Graphics

Drivers .

Microsoft Windows 10 Microsoft Windows 7

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

NVIDIA® Quadro® P2000 5GB Graphics

Form Factor

Dimensions: 4.4"?Hx7.9"?L

Single Slot Cooling: Active Weight: 260 grams

Graphics Controller NVIDIA® Quadro® P2000 Graphics Card

Power: 75 Watts

Bus TypePCI Express 3.0 x16MemorySize: 5GB GDDR5

Memory Bandwidth: 140 GB/s Memory Width: 160-bit

Connectors 4x DisplayPortTM 1.4

Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included

Additional DVI to VGA, DisplayPort[™] to VGA, DisplayPort[™] to DVI, and

DisplayPortTM to Dual-Link DVI adapters available as accessories.

Maximum Resolution DisplayPortTM:

Technical Specifications - Graphics

- up to 5120 x 2880 x 24 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 &

1.4 ready.

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60 Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

HDMI 2.0 (requires DP to HDMI adapter):

5120 x 2880 x 24 bpp @ 60Hz

Image Quality Features 12-bit internal display pipeline (hardware support for 12-bit scanout on

supported panels, applications and connection)

Stereoscopic 3D display support including NVIDIA® 3D VisionTM technology,

NVIDIA® Mosaic and nView.

Display Output Maximum number of displays

- 4 direct attached monitors

Maximum number of monitors across all available NVIDIA® Quadro® P2000

outputs is 4.

Shading Architecture

Supported Graphics APIs

Shader Model 5.1

OpenGL[®] 4.5 DirectX[®] 12

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCLTM, Java, Python, and Fortran

software

Available Graphics

Drivers

Microsoft Windows 10

Microsoft Windows 7 Professional 64bit

Linux $^{\!0}$ - Full OpenGL $^{\!0}$ implementation, complete with NVIDIA $^{\!0}$ Quadro $^{\!0}$ and

ARB extensions

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Notes

NVIDIA® Quadro® P2200 5GB Graphics **Form Factor**

Dimensions: 4.4"?H x 7.9"?L

Single Slot, Full Height Weight: 260 grams

Graphics Controller NVIDIA® Quadro® P2200 Graphics Card

GPU: 1280 CUDA cores Power: 75 Watts Cooling: Active

Bus TypePCI Express 3.0 x16MemorySize: 5GB GDDR5X

Memory Bandwidth: 200 GB/s

Memory Width: 160-bit

Connectors 4x DisplayPortTM 1.4



Technical Specifications - Graphics

Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included

Additional DVI to VGA. DisplayPortTM to VGA. DisplayPortTM to DVI. and DisplayPortTM to Dual-Link DVI adapters available as accessories.

Maximum Resolution

DisplayPortTM:

- up to 5120 x 2880 x 24 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 &

1.4 ready.

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60 Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

HDMI 2.0 (requires DP to HDMI adapter):

5120 x 2880 x 24 bpp @ 60Hz

Image Quality Features

12-bit internal display pipeline (hardware support for 12-bit scanout on

supported panels, applications and connection)

Stereoscopic 3D display support including NVIDIA® 3D VisionTM technology,

NVIDIA® Mosaic and nView.

Display Output

Maximum number of displays - 4 direct attached monitors

Maximum number of monitors across all available NVIDIA® Ouadro® P2200

outputs is 4.

Shading Architecture

Supported Graphics APIs

Shader Model 5.1

OpenGL® 4.5 DirectX[®] 12

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCLTM, Java, Python, and Fortran

software

Available Graphics

Drivers

Microsoft Windows 10

Microsoft Windows 7 Professional 64bit

Linux® - Full OpenGL® implementation, complete with NVIDIA® Quadro® and

ARB extensions

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Notes

Quadro P2200 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.

Quadro P2200 offered as an After Market Option does not include video

cables. Video cable adapters must be ordered separately.

Technical Specifications - Graphics

AMD RadeonTM Pro WX 3100 4GB Graphics Form Factor Low-Profile Single Slot (6.6"? Length)

Graphics Controller Polaris12 GL
GPU: 512 Stream Processors organized into 8 Compute Units

Power: 50 Watts Cooling: Active

Memory 4GB GDDR5 memory

Memory Bandwidth: 6 Gbps / 96 GB/s

Memory Width: 128 bit

Connectors 2x Mini DisplayPortTM 1.4 plus 1x DisplayPortTM 1.4 - HDR ready connectors

with HBR3 and MST support.

Factory Configured: No adapters included

After market option kit: One mDP-to-DP cable adapters included Additional Mini DisplayPortTM-to-DisplayPortTM, DisplayPortTM-to-VGA or DisplayPortTM-to-DVI adapters are available as Factory Configuration or

Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

3x 4K support @ 60Hz

Image Quality Features Advanced support for 8-bit and 10-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 3 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture

Supported Graphics APIs DirectX[®]12

OpenGL® 4.5 OpenCLTM 2.0 VulkanTM 1.0

Polaris

Available Graphics Drivers Windows 10 64-bit

(Windows® 7 64-bit available from AMD) Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

- HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- 2. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FireProTM and RadeonTM Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 3. As of September 2016, certified for DisplayPortTM 1.4 HBR3 and ready for DisplayPortTM 1.4 HDR based on independent verification by DisplayPortTM testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Technical Specifications - Graphics

AMD RadeonTM Pro WX 3200 4GB Graphics Form Factor Low-Profile Single Slot (2.75 "H x 6.6"? L)
Graphics Controller RadeonTM Pro WX 3100 Graphics Card

GPU: 640 Stream Processors organized into 8 Compute Units

Power: 56 Watts Cooling: Active

Memory 4GB GDDR5 memory

Memory Bandwidth: 6 Gbps / 96 GB/s

Memory Width: 128 bit

Connectors 2x Mini DisplayPortTM 1.4 plus 1x DisplayPortTM 1.4 - HDR ready connectors

with HBR3 and MST support.

Factory Configured: No adapters included

After market option kit: One mDP-to-DP cable adapters included

Additional Mini DisplayPortTM-to-DisplayPortTM, DisplayPortTM-to-VGA or DisplayPortTM-to-DVI adapters are available as Factory Configuration or

Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

3x 4K support @ 60Hz

Image Quality Features Advanced support for 8-bit and 10-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 3 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture

Supported Graphics APIs DirectX[®]12

OpenGL® 4.5 OpenCLTM 2.0 VulkanTM 1.0

Polaris

Available Graphics Drivers Windows 10 64-bit

(Windows® 7 64-bit available from AMD) Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

- 4. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- 5. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FireProTM and RadeonTM Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 6. As of September 2016, certified for DisplayPortTM 1.4 HBR3 and ready for DisplayPortTM 1.4 HDR based on independent verification by DisplayPortTM testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Technical Specifications - Graphics

AMD Radeon™ Pro WX 4100 4GB Graphics

Form Factor Low-Profile Single Slot (6.6"? Length) **Graphics Controller**

Polaris 11 Baffin GL XT

GPU: 1024 Stream Processors organized into 16 Compute Units

Power: 50 Watts Cooling: Active

4GB GDDR5 memory Memory

Memory Bandwidth: 6 Gbps / 96 GB/s

Memory Width: 128 bit

4x Mini DisplayPortTM 1.4 - HDR ready connectors with HBR3 and MST **Connectors**

support.

Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included

Additional DisplayPortTM-to-VGA or DisplayPortTM-to-DVI adapters are

available as Factory Configuration or Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

• 1x single-cable 5K monitor, or 2x dual-cable 5K monitors

4x 4K support @ 60Hz

Advanced support for 8-bit and 10-bit per RGB color component. High **Image Quality Features**

bandwidth scaler for high quality up and downscaling

4 full physical DP1.3 HBR3 / DP1.4 HDR outputs **Display Output**

FreeSync support

GPU Architecture

Supported Graphics APIs

GCN 4th Generation

DirectX[®]12 OpenGL® 4.5 OpenCLTM 2.0 VulkanTM 1.0

Available Graphics Drivers Windows 10 64-bit

Windows® 7 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

- 7. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FireProTM and RadeonTM Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- As of September 2016, certified for DisplayPortTM 1.4 HBR3 and ready for DisplayPortTM 1.4 HDR based on independent verification by DisplayPortTM testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Technical Specifications - Graphics

NVIDIA® Ouadro® P4000 **8GB Graphics**

Form Factor Dimensions: 4.4"?H x 9.5"?L

Single-slot, full-height

Weight: 475 grams (without extender)

NVIDIA® Ouadro® P4000 Graphics Card **Graphics Controller**

GPU: GP104 with 1792 CUDA cores

Power: 120 Watts

PCI Express 3.0 x16 **Bus Type** Memory Size: 8GB GDDR5

> Memory Bandwidth: 243 GB/s Memory Width: 256-bit

4 x DisplayPort 1.4 **Connectors**

3-pin mini-DIN connector via optional bracket

1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Ouadro® Sync II

2 x SLI connectors

Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included

Additional DisplayPort-to-VGA, DisplayPort-to-HDMI, or DisplayPort-to-DVI

adapters are available as accessories

Maximum Resolution Dual-link internal TMDS (DVI 1.0):

- up to 2560 x 1600 x 32 bpp @ 60 Hz

Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz

HDMITM 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz

DisplayPort:

- up to 4096 x 2160 x 30 bpp @ 60Hz - up to 2560 x 1600 x 30 bpp @ 120 Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

Using two DP outputs, the P4000 can drive one dual DP input display with

5120 x 2880 x 30 bpp @ 60Hz resolution.

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPort, DVI, and HDMI connectors

NVIDIA 3D VisionTM and other 3D stereo technologies

NVIDIA Mosaic and nView

Display Output Maximum number of displays

- 4 direct attached monitors

Maximum number of monitors across all available Quadro P4000 outputs is

4.

Shading Architecture

OpenGL 4.5

Supported Graphics APIs

DirectX 12 Vulcan 1.0

Shader Model 5.1



Technical Specifications - Graphics

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics

Drivers

Microsoft Windows 10 Microsoft Windows 7

Linux® - Full OpenGL implementation, complete with NVIDIA and ARB

extensions

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

1. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.

2. Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

NVIDIA® Quadro® P5000 16GB Graphics

Form Factor

Full-Height Dual Slot (4.4"? Height x 10.5"? Length)

Weight: 815 grams / 1.80 lbs

Graphics Controller

NVIDIA® Quadro® P5000 graphics

GPU: 2560 NVIDIA® CUDA® Parallel Processing Cores

Power: 180 Watts Cooling: Active

Memory

16GB GDDR5X memory

Memory Bandwidth: Up to 288 GB/s

Memory Width: 256 bit

ECC Memory (disabled by default)

Connectors

DP (x4) with HDR support

DL-DVI(D)

3-pin mini-DIN connector

SLI connector

NVIDIA® Quadro® Sync connector (compatible with NVIDIA® Quadro®

One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPortTM to VGA, DisplayPortTM to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort[™], DVI, and HDMI

connectors

Technical Specifications - Graphics

NVIDIA 3D Vision[™] and other 3D stereo technologies NVIDIA[®] Mosaic and nView Desktop Management

Display Outputs¹ 4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or

up to 8K at 30Hz)

1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and

1920x1200 @ 120 Hz)

GPU Architecture NVIDIA PascalTM

Supported Graphics DirectX°12, OpenGL° 4.5, OpenCLTM 1.0, VulkanTM 1.0

APIS Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCLTM, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

NVIDIA® Quadro® P6000 24GB Graphics **Form Factor** Full-Height Dual Slot (4.4"? Height x 10.5"? Length)

Weight: 967 grams / 2.14 lbs

Graphics Controller NVIDIA® Ouadro® P6000 graphics

GPU: 3840 NVIDIA® CUDA® Parallel Processing Cores

Power: 250 Watts Cooling: Active

Memory 24GB GDDR5X memory

Memory Bandwidth: Up to 432 GB/s

Memory Width: 384 bit

ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

DL-DVI(D)

3-pin mini-DIN connector

SLI connector

NVIDIA® Quadro® Sync connector (compatible with NVIDIA®

Quadro® II Sync)

One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with

card.

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPortTM to VGA, DisplayPortTM to DVI, and DisplayPortTM to Dual-Link DVI adapters available as accessories.



Technical Specifications - Graphics

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort[™], DVI, and HDMI

connectors

NVIDIA 3D VisionTM and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs1

4x DP1.4 HDR outputs (up to 3840x2160 UHD @ 120Hz refresh, or

up to 8K at 30Hz)

1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz and

1920x1200 @ 120 Hz)

GPU Architecture

NVIDIA PascalTM

Supported Graphics

APIs

DirectX[®]12, OpenGL[®] 4.5, OpenCLTM 1.0, VulkanTM 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0. OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

1- Supports up to a total of 4 displays

NVIDIA® Quadro® RTX Form Factor 4000 8GB Graphics

Full-Height Single Slot (4.4"? Height x 9.5"? Length)

Weight: 550 grams / 1.21 lbs

Graphics Controller

NVIDIA® Quadro® RTX 4000 Graphics

TU104 GPU

GPU: 2304 NVIDIA® CUDA® Parallel Processing Cores

Power: 160 Watts Cooling: Active

Memory

8GB GDDR6 memory

Memory Bandwidth: Up to 416 GB/s

Memory Width: 384 bit

Connectors

3x DP 1.4a and VirtualLink

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

Factory configured option: No video cable adapter included with

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPortTM to VGA, DisplayPortTM to DVI, and DisplayPortTM to Dual-Link DVI adapters available as accessories.



Technical Specifications - Graphics

Maximum Resolution 7680x4320 @ 60Hz

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort[™], DVI, and HDMI

connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹

3x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)

Supported Graphics

APIs

DirectX[®]12, OpenGL[®] 4.5, OpenCLTM 1.0, VulkanTM 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0. OpenCLTM, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

1- Supports up to a total of 4 displays Notes

NVIDIA® Quadro® RTX Form Factor

5000 16GB Graphics

Full-Height Dual Slot (4.4"? Height x 10.5"? Length)

Weight: 1050 grams / 2.31 lbs

Graphics Controller

NVIDIA® Quadro® RTX 5000 Graphics

TU104 GPU

GPU: 3072 NVIDIA® CUDA® Parallel Processing Cores

Power: 265 Watts Cooling: Active

Memory

16GB GDDR6 memory

Memory Bandwidth: Up to 448 GB/s

Memory Width: 384 bit

Connectors

4x DP 1.4a and VirtualLink

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin + 6-pin auxiliary power connector

Factory configured option: No video cable adapter included with

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPortTM to VGA, DisplayPortTM to DVI, and DisplayPort[™] to Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort[™], DVI, and HDMI

Technical Specifications - Graphics

connectors

NVIDIA® 3D VisionTM and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs1

4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)

Supported Graphics

APIs

DirectX[®]12, OpenGL[®] 4.5, OpenCLTM 1.0, VulkanTM 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

1- Supports up to a total of 4 displays **Notes**

NVIDIA® Quadro® RTX Form Factor 6000 24GB Graphics

Full-Height Dual Slot (4.4"? Height x 10.5"? Length)

Weight: 1070 grams / 2.35 lbs

Graphics Controller

NVIDIA® Quadro® RTX 6000 Graphics

TU102 GPU

GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores

Power: 295 Watts Cooling: Active

Memory

24GB GDDR6 memory

Memory Bandwidth: Up to 672 GB/s

Memory Width: 384 bit

Connectors

4x DP 1.4a and VirtualLink

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin + 6-pin auxiliary power connector

Factory configured option: No video cable adapter included with

card.

After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPortTM to VGA, DisplayPortTM to DVI, and DisplayPortTM to Dual-Link DVI adapters available as accessories.

Maximum Resolution 7680x4320 @ 60Hz

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB

color component.

HDCP 2.2 support over DisplayPort[™], DVI, and HDMI

connectors

NVIDIA® 3D VisionTM and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹

4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)

Technical Specifications - Graphics

Supported Graphics

APIs

DirectX[®]12, OpenGL[®] 4.5, OpenCLTM 1.0, VulkanTM 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0. OpenCL™, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes 1- Supports up to a total of 4 displays

NVIDIA® Quadro® RTX 8000 48GB Graphics

Form Factor

Full-Height Dual Slot (4.4"? Height x 10.5"? Length)

Weight: 1070 grams / 2.35 lbs

Graphics Controller

NVIDIA® Ouadro® RTX 8000 Graphics

GPU: 4608 NVIDIA® CUDA® Parallel Processing Cores

Power: 295 Watts Cooling: Active

Memory

48GB GDDR6 memory

Memory Bandwidth: Up to 672 GB/s

Memory Width: 384 bit

Connectors

4x DP 1.4a and VirtualLink

Ouadro Sync connector (compatible with Ouadro II Sync)

One 8-pin + 6-pin auxiliary power connector

Factory configured option: No video cable adapter included with card. After market option Kit: No video cable adaptor included with card.

DVI to VGA, DisplayPortTM to VGA, DisplayPortTM to DVI, and DisplayPortTM to

Dual-Link DVI adapters available as accessories.

Maximum Resolution

7680x4320 @ 60Hz

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPortTM, DVI, and HDMI connectors

NVIDIA® 3D VisionTM and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Outputs¹

4x DP 1.4a and VirtualLink (7680x4320 @ 60Hz)

Supported Graphics APIs

DirectX[®]12, OpenGL[®] 4.5, OpenCLTM 1.0, VulkanTM 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0.

OpenCLTM, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support Web

http://welcome.hp.com/country/us/en/support.html

Notes

Supports up to a total of 4 displays

VirtualLink's USB-CTM (data) cannot be disabled at a hardware level



Technical Specifications - Graphics

NVIDIA® Quadro® GP100 16GB Graphics **Form Factor** Dual Slot (4.4"? Height x 10.5"? Length)

Weight: 989 grams +72 grams extender

Graphics Controller NVIDIA® QUADRO® GP100

GPU: 3584 NVIDIA CUDA® Parallel Processing Cores

Power: 235 Watts Cooling: Active

Memory 16GB HBM2

Memory Bandwidth: Up to 717 GB/s

Memory Width: 4096-bit

ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

DL-DVI(D)

3-pin mini-DIN connector via optional bracket

4-pin header for stereo signal

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

(2x) NVLink connectors

Factory configured option: 8-pin power adapter included with

card.

After market option Kit: 8-pin power adapter included with card.

DVI to VGA, DisplayPortTM to VGA, DisplayPortTM to DVI, and DisplayPortTM to Dual-Link DVI adapters available as accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features HDR support over DisplayPortTM 1.4 (SMPTE 2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC

Decode, 4K @ 60 Hz 10b HEVC Encode)

HDCP 2.2 support over DisplayPortTM, DVI, and HDMI

connectors

NVIDIA 3D VisionTM technology

NVIDIA Mosaic and nView Desktop Management

Display Outputs 4x DP1.4 MST & HDR2 outputs (up to 5120 x 2880 @ 60Hz)

1x Dual-link DVI-D output (up to 2560 x 1600 @ 60 Hz) 1x Single-link DVI-D output (up to 1920 x 1200 @ 60 Hz)

HDMITM 2.0b (up to 5120 x 2880 @ 60Hz)*

*requires DP to HDMI adapter

GPU Architecture NVIDIA PascalTM

Supported Graphics

APIS

DirectX®12, OpenGL® 4.5, VulkanTM 1.0

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCL, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10

Windows® 7 Professional 64-bit

Linux®



Technical Specifications - Graphics

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured (Z840 Workstations): No adapters included Factory Configured (Z4 G4/ Z6 G4/ Z8 G4 Workstations): No

adapters included

After market option kit: No adapters included

NVIDIA® Quadro® GV100 32GB Graphics Form Factor Dual Slot (4.4"? Height x 10.5"? Length)

Weight: 980 grams + 72 gram extender

Graphics Controller NVIDIA® QUADRO® GV100

GPU: 5120 NVIDIA® CUDA® Parallel Processing Cores

Power: 250 Watts Cooling: Active

Memory 32GB HBM2 memory

Memory Bandwidth: Up to 870 GB/s

Memory Width: 5120-bit

ECC Memory (disabled by default)

Connectors DP (x4) with HDR support

3-pin mini-DIN connector via optional bracket

4-pin header for stereo signal

Quadro Sync connector (compatible with Quadro II Sync)

One 8-pin auxiliary power connector

(2x) NVLink for GV100 connectors (via optional kit)

After market option Kit: no power adapter included with card.

DisplayPortTM to VGA, DisplayPortTM to DVI (single-link and dual-link), and DisplayPortTM to HDMI adapters available as accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features HDR support over DisplayPort[™] 1.4 (SMPTE

2084/2086, BT. 2020) (4K @ 60 Hz 10b/12b HEVC

Decode, 4K @ 60 Hz 10b HEVC Encode)

HDCP 2.2 support over DisplayPort[™] and HDMI

connectors

NVIDIA 3D VisionTM technology

NVIDIA Mosaic and nView Desktop Management

Display Outputs 4x DP1.4 HDR2 outputs (up to 5120 x 2880 @ 60Hz)

GPU Architecture NVIDIA® VoltaTM

Technical Specifications - Graphics

Supported Graphics

APIs

DirectX®12, OpenGL® 4.5

Developer API support includes: CUDA C, CUDA C++, DirectCompute

5.0, OpenCLTM, Java, Python, and Fortran

Available Graphics

Drivers

Windows® 10 64-bit Windows® 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP

support Web site:

http://welcome.hp.com/country/us/en/support.html

Factory Configured (Z4/Z8 G4 Workstation): No adapters included

After market option kit: No adapters included

AMD RadeonTM Pro WX 7100 8GB Graphics

Form Factor

Graphics Controller

Full-Height Single Slot (9.5"? Length)
RadeonTM Pro WX 7100 graphics

GPU: 2304 Stream Processors organized into 36 Compute Units

Power: 130 Watts Cooling: Active

Memory

8GB GDDR5 memory

Memory Bandwidth: 7 Gbps / 224 GB/s

Memory Width: 256 bit

Connectors

4x Display Port 1.4 - HDR ready connectors with HBR3 and MST support.

Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

Additional DisplayPort[™]-to-VGA or DisplayPort[™]-to-DVI adapters are

available as Factory Configuration or Option Kit accessories.

Maximum Resolution

5K support @ 60Hz

• 1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features

Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and

downscaling

Display Output

4 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture

Supported Graphics APIs

GCN 4th Generation

DirectX[®]12 OpenGL[®] 4.5

Available Graphics Drivers Windows 10 64-bit

OpenCLTM 2.0 VulkanTM 1.0

Windows® 7 64-bit Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support Web

site:

http://welcome.hp.com/country/us/en/support.html

Notes

10. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV,

Technical Specifications - Graphics

graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

- 11. Radeon VR Ready Creator Products are select Radeon Pro and AMD FireProTM GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice.
- 12. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FireProTM and RadeonTM Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 13. As of September 2016, certified for DisplayPortTM 1.4 HBR3 and ready for DisplayPortTM 1.4 HDR based on independent verification by DisplayPortTM testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

AMD RadeonTM Pro WX 9100 16GB Graphics

Form Factor Dual Slot (4.4"? Height x 10.5"? Length)

Graphics Controller RadeonTM Pro WX 9100 graphics

GPU: 4096 Stream Processors

Power: 250 Watts Cooling: Active

Memory 16GB HBM2 memory

Memory Bandwidth: Up to 483 GB/s

Memory Width: 2048 bit

Connectors 6x Mini DisplayPort 1.4 - HDR ready connectors with HBR3 and MST support.

Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

Additional DisplayPort-to-VGA or DisplayPort-to-DVI adapters are available

as Factory Configuration or Option Kit accessories.

Maximum Resolution 8K support @ 60Hz

Single monitor, single or dual-cable

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 6 full physical mDP 1.4 HDR Ready outputs

FreeSync support

GPU Architecture VegaTM



Technical Specifications - Graphics

Supported Graphics APIs

DirectX[®] 12.1 OpenGL[®] 4.5 OpenCLTM 2.0 VulkanTM 1.0

Available Graphics Drivers Windows 10 64-bit

Windows 7 available from AMD

Linux® 64-bit

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

- HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
- Radeon VR Ready Creator Products are select Radeon Pro and AMD FireProTM GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice.
- 3. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FireProTM and RadeonTM Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 4. As of September 2016, certified for DisplayPortTM 1.4 HBR3 and ready for DisplayPortTM 1.4 HDR based on independent verification by DisplayPortTM testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Technical Specifications - Graphics

NVIDIA® Quadro® Sync II

Part number 1WT20AA

Dimensions (HxD) 6.0 inches? 4.2 inches **Devices Supported** NVIDIA® Ouadro® P4000 NVIDIA® Quadro® P5000

NVIDIA® Ouadro® P6000

Bus Type Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector

PCI Form Factor Full Height, half length, single slot

Ports 2 RJ45 connectors for carrying frame lock signals over CAT5 cables.

BNC Connector for external house synchronization.

Internal Connectors 6 NVIDIA SLI® style edge fingers for connection to compatible GPUs

> Included with the board are 4 12-Inch Short Sync Cables to connect to GPU's

> Included with the board are 2 24-Inch Long Sync Cables to connect to GPU's

System Requirements Requires one free mechanical PCIe bus slot. 6-pin PCI or SATA power connector

Must be used with NVIDIA Quadro P4000, P5000 or P6000 graphics cards.

Requires Quadro driver version R375 or later.

Temperature -

Operating

0° to 55° C

Temperature - Storage -40° to 60° C **Relative Humidity -**10% to 80%

Operating

Power Requirements Board power dissipation: <15W

Operating Systems Supported

Windows 10 64-bit Windows 7 64-bit

Linux® 64-bit

Kit Contents Contains:

Quadro Sync II Card

 4 x 12-Inch Short Sync Cables • 2 x 24-Inch Long Sync Cables (Two)

Quick Start Guide

Technical Specifications – Optical and Removable Storage

Optical and Removable Storage

HP 9.5mm Slim DVD Writer **Description** 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types DVD+R

DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Full Stroke DVD < 200 ms (seek)
Full Stroke CD < 200 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Power Source SATA DC power receptacle

DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC -< 800 mA typical, <1600 mA

maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions non-
condensing)Relative Humidity10% to 80%
84° F (29° C)Maximum Wet Bulb Temperature84° F (29° C)

Operating Systems

Supported

Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000.

Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation

SUSE Linux® Enterprise Desktop 12

* No driver is required for this device. Native support is provided by the

operating system.

Kit Contents HP SATA DVD Writer drive, installation guide.

Technical Specifications – Optical and Removable Storage

HP 9.5mm Slim DVD-ROM Drive

Description 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA / ATAPI Dimensions (WxHxD) 128 x 9.5 x 127mm

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double laver: Up to 8.5 GB

Access Times DVD-ROM Single Layer < 110 ms (typical)

CD-ROM Mode 1 < 110 ms (typical) Full Stroke DVD < 230 ms (typical) Full Stroke CD < 220 ms (typical)

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC - <800mA typical, < 1600 mA

maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)

Operating Systems

Windows 10, Windows 8.1, Windows 7 Professional 64-bit Supported Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation

SUSE Linux® Enterprise Desktop 12

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim DVD-ROM Drive, 5.25" ODD Bay adapter/carrier, slim SATA

data/power cable, installation guide

HP HH DVD Writer (16X RW DVD-R)

HP Half Height DVD Writer Description **Mounting Orientation** Either Horizontal or vertical

Interface Type SATA

Dimensions (WxHxD) 146x42x165mm

Supported Media Types DVD+R

DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

> Full Stroke DVD 145ms (seek) Full Stroke CD 120ms (seek)

Maximum Data Transfer

Rates

CD ROM Read

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 13X

> DVD-RW Up to 13X DVD+R DL Up to 12X DVD-R DL Up to 12X DVD-ROM Up to 12X

Technical Specifications – Optical and Removable Storage

DVD-ROM DL Up to 12X DVD+R Up to 16X DVD-R Up to 16X

Power Source SATA DC power receptacle

> DC Power Requirements 5 VDC ± 5% -100 mV ripple p-p

12 VDC ± 10% -200 mV ripple p-p

DC Current 5 VDC -<1500mA typical, <2000 mA

maximum.

Operating Environmental Temperature

(all conditions non-

condensing)

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 90% (Non-Condensing)

Operating Systems

Supported

Windows 10, Windows 7 Professional 64-bit. Red Hat Enterprise Linux

WS4**,5,6 Desktop/Workstation.

No driver is required for this device, Native support is provided by operating

svstem.

Kit Contents HP SATA DVD Writer drive, Installation guide.

HP 9.5mm Slim BDXL Blu-**Ray Writer**

Description

9.5mm height, tray-load Either horizontal or vertical

Mounting Orientation Interface Type

SATA/ATAPI

BD-ROM

Dimensions (WxHxD)

128 x 9.5 x 127mm

Supported Media Types

BD-R **BD-RE** DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R **DVD-RW** CD-R CD-RW

Disc Capacity

DVD-ROM

8.5 GB DL or 4.7 GB standard

Blu-ray 25 GB (single-laver) 50 GB (dual-layer)

100/128 GB (BDXL)

Full Stroke DVD < 230 ms (seek) Full Stroke CD < 220 ms (seek)

< 230 ms (seek) (Full Stroke Blu-ray) Blu-ray (Time to drive ready from tray loading) **Startup Time**

> BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 255 / 285 BD-RE (SL/DL) 255 / 285 DVD-ROM (SL/DL) 18S / 18S 25S / 25S

DVD-R (SL/DL) **25S** DVD-RW

DVD+R (SL/DL) 25S / 25S

DVD+RW **25S** CD-ROM **15S**

Technical Specifications – Optical and Removable Storage

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

BD-ROM Up to 6X Blu-ray

> BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X

Power SATA DC power receptacle Source

> DC Power Requirements 5 VDC ± 5%-100 mV ripple p-p **DC Current** 5 VDC -900 mA typical, 2000mA

> > maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions non-**Relative Humidity** 10% to 80% condensing) Maximum Wet Bulb Temperature 84° F (29° C)

Operating Systems Windows 10. Windows 7 Professional 64-bit. Supported

Red Hat® Enterprise Linux® (RHEL) 6, 7 Desktop/Workstation

SUSE Linux® Enterprise Desktop 12

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim SATA

data/power cable, installation guide

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD

movies cannot be played on this workstation.



Technical Specifications – Optical and Removable Storage

HP SD Card Reader

Description Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports SD 4-bit parallel transfer mode

Interface Type USB 3.1 Gen 1 High-speed interface

Dimensions (WxHxD) 1.15 x .9 x .15 in (29.00 x 23.6 x 3.15 mm) Fits conveniently in the Front IO

Bay

Supported Media Types Secure Digital Card (SD)

Secure Digital High Capacity (SDHC)
SD Extended Capacity Memory Card (SDXC)

SD Ultra High Speed II(SD UHSII)

These additional media types are supported with a card adapter.

Memory Stick Micro (M2)

miniSD

miniSD High Capacity

Micro SD Memory Card (MicroSD)

Micro SD High Capacity Memory Card (MicroSDHC)

Test Parameters/Conditions - Power applied, unit operating on system ±5%

Operating Systems

Supported

Windows 10

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents Media card reader

Approvals USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0,

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE,

BSMI, C-Tick, VCCI, MIC, cUL, TUVT

Weight 0.35 lbs. (0.16 kg)

Technical Specifications - Controller Cards

Controller Cards

HP Thunderbolt-3 Dual Data Transfer Rate
Port2 PCIe 1-port I/O Card Devices Supported

Data Transfer Rate Supports up to 40 Gb/s (40,000 Mb/s)

Devices Supported ThunderboltTM, ThunderboltTM 2 and ThunderboltTM 3 certified for Windows

devices

Bus Type PCIe card, full height PCIe slots

Ports Two ThunderboltTM 3 external USB type-C output connectors (Rear)

Two full size DisplayPort input connectors (Rear)

Internal Connectors One 2x5-Pin header connector

System Requirements Windows 10 Professional 64-bit, available dedicated PCH PCIe slot.

Temperature - Operating 50° to 131° F (10° to 55° C) **Temperature - Storage** -22° to 140° F (-30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Compliances FCC Part 15B. cULus 60950. CE Mark EN55022B(1995)/EN55024-1998 STD.

Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Genuine Windows 10 Professional 64-bit.

Kit Contents HP ThunderboltTM 3 Dual Port PCIe I/O Card, 2- DisplayPort cables, GPIO

(General-Purpose Input/Output) cables, Installation documentation and

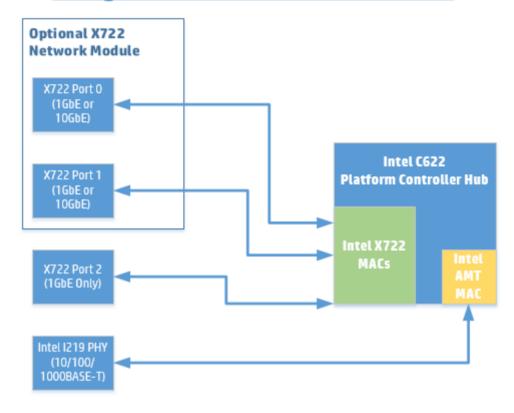
warranty card.

^{*}Maximum speed requires DisplayPortTM and PCIe aggregation.

Technical Specifications - Networking and Communications

Networking and Communications

HP Z6 Gen4 and HP Z8 Gen 4 Integrated Network Architecture



Note: When an optional X722 network module is not installed in the system, a "dummy" port is enumerated as Function 0 of the Intel X722 MACs, which allows for the X722 Port 2 on the Motherboard to enumerate.

Integrated Intel I219LM

Connector RJ-45
Controller Intel I219LM
Data Rates Supported 10/100/1000

Data Rates Supported 10/100/1000 Mbps **Boot ROM Support** PXE, UEFI

Connect Speed LED Link/Activity LED Indicators

Off = No linkBlinking = Activity

Speed LED

• Off = 10Mbps

• Amber = 100Mbps

• Green = 1000Mbps

Management Capabilities Intel® Active Management TechnologyTM 11



Technical Specifications - Networking and Communications

Integrated Intel X722 for 1GbE

Connector

1 RJ-45

Controller

Intel X722 for 1GbE

Data Rates Supported

1000 Mbps

Boot ROM Support

PXE, UEFI

Connect Speed LED

Indicators

Link/Activity LED

• Off = No link

Blinking = Activity

Speed LED

• Off = No Link

• Green = 1000Mbps

Management Capabilities Wake-On-LAN

HP Z Dual 10GbE Network Networking Interface Module

2 RJ-45

System Interface

Cabled from Dedicated Rear I/O Slot

Networking Speeds

Supported

1Gbps, 10Gbps

Cabling (up to 100m)

Cat5e (or higher) for 1Gbps

Cat6a (or higher) for 10Gbps

Power Consumption

(active-typical)

5.5W at 1Gbps 11.2W at 10Gbps

Physical Dimensions

0.875 in x 3 in x 2.75 in

Connect Speed LED

Link/Activity LED

Indicators

• Off = No link

Blinking = Activity

Speed LED

Amber = 1Gbps

• Green = 10Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Technical Specifications - Networking and Communications

Intel® I210-T1 Networking Interface

System Interface PCI Express 2.1 x1

Networking Speeds 10Mbps,

Supported

10Mbps, 100Mbps, 1Gbps

Cabling (up to 100m) Cat3

Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps

Power Consumption (active-typical)

0.81W

1 RJ-45

Physical Dimensions

Length: 6.7cm (2.64 inches)

(Bracket) Width: 1.8cm (0.709 inches)

Full-height end bracket: 12.07cm (4.755 inches) Low-profile end bracket: 8cm (3.15 inches)

Connect Speed LED Indicators

Link/Activity LED

Off = No linkBlinking = Activity

Speed LED

• Off = 10Mbps

• Green = 100Mbps

Amber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B, EU: UL CE,

EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Intel® 1350-T2

Networking Interface

2 RJ-45

System Interface

PCI Express 2.1 x4

Networking Speeds

10Mbps, 100Mbps, 1Gbps

Supported Cabling (up to 100m)

Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps

Cat5e (or higher) for 1Gbps

Power Consumption (active-typical)

4.4W

Physical Dimensions

Length: 13.54cm (5.33 inches) Width: 6.89 (2.71 inches)

Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)

Connect Speed LED Indicators

Link/Activity LED

• Off = No link

• Blinking = Activity

Speed LED

Off = 10Mbps

• Green = 100Mbps

Technical Specifications - Networking and Communications

Amber = 1Gbps0 °C to 55 °C (32 °F to 131 °F)

Operating Temperature

Hardware Certifications USA: FCC B,

EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Intel® 1350-T4 Networking Interface 4 RJ-45

System Interface PCI Express 2.1 x4

Networking Speeds

Supported

10Mbps, 100Mbps, 1Gbps

Cabling (up to 100m) Cat3 (or higher) for 10Mbps

Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps

Power Consumption (active-typical)

Physical Dimensions

Length: 13.54cm (5.33 inches)

Width: 6.89 (2.71 inches)

Full-height end bracket: 12.0cm (4.725 inches) Low-profile end bracket: 7.92cm (3.117 inches)

Connect Speed LED Indicators

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

5W

• Off = 10Mbps

• Green = 100Mbps

Amber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B, EU: UL CE, Iapan: VCCI

Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK,

Korea: KCC,

Canada: ICES-003/NMB-003

Technical Specifications - Networking and Communications

Aquantia® AQN-108

Networking Interface RJ-45

System Interface PCI Express 3 x1

Networking Speeds

Supported

100Mbps, 1Gbps, 2.5Gbps, 5Gbps

Cabling (up to 100m) **Power Consumption**

Cat5e (or higher) for all speeds

(active-typical)

3.5W at 5Gbps, 3.0W at 2.5Gbps

Physical Dimensions

3.72 in x 3.18 in (without bracket)

Connect Speed LED Indicators

Link/Activity LED

• Off = No link

Blinking = Activity

Speed LED

• Off = No link

• Amber = <5Gbps

• Green = 5Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B.

EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK.

Korea: KCC.

Canada: ICES-003/NMB-003

Intel® X550-T2

Networking Interface

2 x RJ-45

System Interface

Supported

PCI Express 3 x4

Networking Speeds

100Mbps, 1Gbps, 2.5Gbps, 5Gbps, 10Gbps

Cabling (up to 100m)

Cat5 (or higher) for 100Mbps

Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps

Cat6a (or higher) for 10Gbps

Power Consumption (active-typical)

3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps

Physical Dimensions

5.2 in x 2.7 in (without bracket)

Connect Speed LED Indicators

Link/Activity LED

Off = No link

Blinking = Activity

Speed LED

• Off = No link

Amber = <10Gbps

• Green = 10Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B.

EU: UL CE, Japan: VCCI,

Technical Specifications - Networking and Communications

Taiwan: BSMI.

Australia/New Zealand: CTICK,

Korea: KCC.

Canada: ICES-003/NMB-003

Intel® X710-DA2 10GBASE-SR Converged **Network Adapter**

Networking Interface

2 SFP+ Ports for LC SFP+ Transceivers

PCI Express 3.0 x8

Networking Speeds

Supported

System Interface

1Gbps, 10Gbps

Cabling

LC fiber optic cabling with LC SFP+ Transceivers

Power Consumption (active-typical)

Physical Dimensions Connect Speed LED

Indicators

6.578 in x 2.703 in Link/Activity LED

- Off = No link Blinking = Activity
- Speed LED
 - Off = 10Mbps • Green = 100Mbps • Amber = 1Gbps

Operating Temperature

0 °C to 55 °C (32 °F to 131 °F)

Hardware Certifications USA: FCC B,

EU: UL CE, Japan: VCCI, Taiwan: BSMI,

Australia/New Zealand: CTICK.

Korea: KCC.

Canada: ICES-003/NMB-003

Note: Windows 7 is NOT supported

10GbE SFP+ SR **Transceiver**

Connector Type LC

62.5/125um or 50/125um (core/cladding), graded-index, low metal content, **Cable Type**

multimode fiber optic, complying with ITU-T G.651 and ISO/IEC 793-2 Type

A1b or A1a, respectively.

Cable Length 2-300m Wavelength 850nm **Form Factor** SFP+

Physical Dimensions 0.47(h) x 0.54(w) x 2.19(d) inches

(1.19 x 1.38 x 5.57 cm)

Operating Temperature OC to 45C (32F to 113F) **Operating Humidity** 0% to 85%, noncondensing

Technical Specifications - Networking and Communications

Intel® 8265 WLAN Networking Speeds 802.11ac MU-MIMO (up to 867 Mbps)

Bluetooth 4.2

IEEE WLAN Standard IEEE 802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w;

802.11r, 802.11k, 802.11v pending

Bluetooth 4.2

System Interface PCI Express 2.1 x1

Antenna 2x2

Intel® 9260 WLAN Networking Speeds 802.11ac MU-MIMO (up to 1.73Gbps using 160MHz channels)

IEEE WLAN Standards IEEE 802.11a/b/g/n/ac

Bluetooth 5.0

System Interface PCI Express 2.1 x1

Antenna 2x2

Summary of Changes

Summary of Changes

		Description of change:
From v1 to v2	Added	Specs for the Power Supply section
	Changed	The System Configurations section and changed notes for the NVIDIA Quadr
		P4000, P5000 & P6000 Graphics
From v2 to v3	Added	HP DisplayPort to HDMI Adapter, NVIDIA SLI 2-slot Graphics Connector and
		NVIDIA Quadro Sync II to Graphics section
	Changed	Graphics, Storage / Hard Drives, Networking and Communications, Other
		Hardware and Memory sections, changed Front view info on the Overview
		section, changed Operating Systems section, changed Processors section,
		changed System Board section, Physical Security and Serviceability section
From v3 to v4	Added	Windows 10 to the supporting systems by the 9.5mm Slim DVD-ROM drive
10111 03 10 04		Microsemi 3152-8i SAS ROC RAID Controller from SAS controller on the Hard
	Removed	Drive Controllers section.
From v4 to v5	Added	Processors, hard drives and graphics to offerings, added Declared Noise
		Emissions information
	Changod	Wattage links on power supply section updated and Voltage links on
	Changeu	efficientcy section updated
From v5 to v6	Changed	Factory configured option to yes on Networking and communications for :
	Changeu	Intel® 8265 802.11 a/b/g/n/ac&BT PCIe
	Damassad	_
		NVIDIA SLI Graphics Connector from Graphics Cable Adapters section
From v6 to v7		RAID 5 and 10 references from "Factory integrated"? in interfaces supported
F 7		section
From v7 to v8	Added	NVIDIA Quadro GP100 16GB Graphics, NVIDIA Quadro GV100 32GB Graphics
		and AMD Radeon Pro WX 9100 16GB Graphics as High End 3D in Graphics
		section
		Intel Xeon processors added
		Footnote to Networking and Communications section
		Operating Systems section
From v9 to v10	Added	Integrated Network Architecture Diagram on The Networking and
		Communications section
i e		Power Supply section
i e		Intel Optane SSD 905p AiC 280GB & 480GB
From v12 to v13		Intel Xeon Gold 6128 processor
	Changed	NVIDIA Quadro P6000 Graphics specs
From v13 to v14	Added	NVIDIA Quadro P620 2GB Graphics
From v14 to v15	Added	HP DX175 Removable HDD Carrier into the HDD Frame/Carriers section
	Changed	Intel Xeon Gold 6126 processor specs
From v15 to v16	Added	Intel Xeon Gold 6126 processor footnote
From v16 to v17	Added	Intel 9260 802.11 a/b/g/n/ac&BT PCIe to Networking section and added HP 2
		Turbo Drive Dual Pro series to Storage section
From v17 to v18	Added	New Intel Xeon Processors and graphics
	Changed	Storage / Hard Drives, Memory sections and format changes
From v18 to v19		NVIDIA Quadro RTX 8000 48GB Graphics
		Networking and Communications section and changed External BIOS
	322	simulator link on Physical Security and Serviceability section
From v19 to v20	Changed	Storage section
		Corrected Intel 905p Series AIC 480GB PCIe SSD
i e	_	Processors Matrix
	_	Graphics section
		Footnote to Memory section, Added Optane 905P 380GB M.2 SSD Module, HF
F10111 V23 (0 V24	Auueu	Z Turbo Drive 1TB SED TLC Z8 G4 SSD Kit & module to Storage section, Adde
		Intel® Wi-Fi 6 AX200 & BT PCIe to Networking section
		TOTAL VVICTORAZUUZIOLEURIUNEIWUKIIIUSELIUI
	From v2 to v3 From v3 to v4 From v4 to v5 From v6 to v7 From v7 to v8 From v9 to v10 From v10 to v11 From v11 to v12 From v12 to v13 From v13 to v14 From v15 to v16 From v15 to v16 From v16 to v17	From v2 to v3 Added Changed From v3 to v4 From v4 to v5 Added Changed From v5 to v6 From v6 to v7 From v7 to v8 Added From v8 to v9 Added From v9 to v10 From v10 to v11 From v10 to v11 Changed From v10 to v12 Added From v12 to v13 Added From v14 to v12 Added From v15 to v16 From v16 to v17 Added From v17 to v18 Added From v18 to v19 Added From v18 to v14 From v16 to v17 Added From v17 to v18 Added From v18 to v10 Added Changed From v16 to v17 Added Changed From v17 to v18 Added Changed From v18 to v19 Added Changed From v19 to v20 Changed From v20 to v21 Changed From v21 to v22 Changed From v22 to v23 Changed

Summary of Changes

November 2, 2019	From v25 to v26	Added	NVDIMM Memory sections, Added HP QX310 Removable NVMe Frame/Carrier w/PCIe card to Optical and Removable Storage section
January 15, 2020	From v26 to v27	Changed	Storage section Storage section
February 26, 2020	From v27 to v28	Added	New Intel Xeon Processors
•		Changed	Overview, PCIe Solid State Drives sections
April 2, 2020	From v28 to v29	Changed	Processors and NVDIMM Memory sections

title

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